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1   Introduction

This document describes the ZSSC3218 Evaluation Kit, including the hardware components, the product-specific configuration, the ZSSC3218 Evaluation Software, and its installation. The software is designed for Windows®-based operating systems to communicate with the ZSSC3218 Evaluation Kit via a USB connection on the user's computer, which functions as a master.

2   Evaluation Kit Overview

The ZSSC3218 Evaluation Kit includes the following hardware components as illustrated in the pink-shaded block in Figure 2.1:

- ZSSC3218 Communication Board (CB), V1.1
- ZSSC3218 Evaluation Board (EB)
- SSC Sensor Replacement Board (SRB)
- Ribbon cable for the connection between the boards (14 pin)
- 5 ZSSC3218 IC samples in a PQFN24 package (DUT)
- USB cable for the connection to a PC

Figure 2.1   ZSSC3218 Evaluation Kit Overview
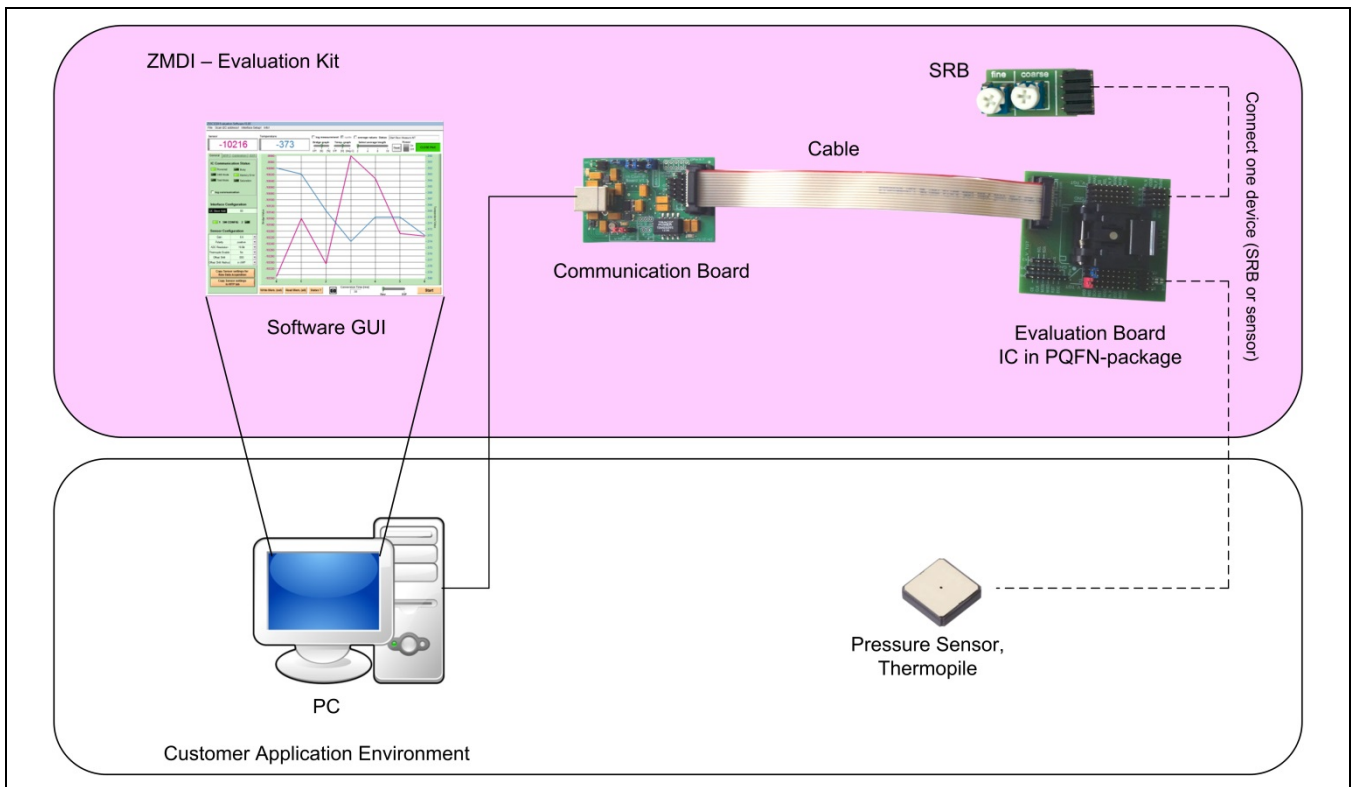
To ensure that users have the most current software revision, the ZSSC3218 Evaluation Software and the documentation are available for download from www.IDT.com/ZSSC3218KIT.

The Evaluation Board provides a connection for a sensor replacement device (e.g., the SRB) or a user sensor module and an alternative 4-pad solder connection for a soldering a sensor on the Evaluation Board. Note: Only one connection can be used at a time.

Schematics for the Communication Board are provided in Appendix A. Schematics for the Evaluation Board are in Appendix B.

2.1. Installing the Software

The ZSSC3218 Evaluation Kit uses an FDTI controller on the Communication Board to handle the USB protocol, translate communications, and synchronize communications with the I^2C™* and/or SPI interface.

2.1.1. Installing the USB Drivers

Before installing the ZSSC3218 Evaluation Software, the USB drivers for the FTDI device must be installed. Download the drivers and corresponding installation guides from www.ftdichip.com/Drivers/D2XX.htm. The Evaluation Software accesses the FTDI controller through the *D2XX DLL*. The drivers will not affect the operation of any other USB peripherals. For installation of the drivers, the user's system must meet these requirements:

- x86-compatible PC
- 64 MB RAM
- Hard drive with 20MB free space
- USB port
- Windows® 2000/XP/Vista/Windows® 7/Windows® 8

Refer to *http://www.ftdichip.com/Support/Documents/InstallGuides.htm* (see section 6) for instructions on installing the correct driver.

2.1.2. Installing ZSSC3218 Evaluation Software

Follow these instructions to install the ZSSC3218 Evaluation Software on the user's PC hard drive. After unzipping the downloaded ZSSC3218 Evaluation Software zip file, navigate to the directory *ZSSC3218 EV SW_vXpxx.* (Note: *Xpxx* refers to the latest version number.) Double click on the *setup.exe* file, and follow the resulting standard installation instructions, entering installation paths and identification as needed. If the default settings have been used, the software automatically completes the installation and creates an access link under *Start > All Programs > ZMDI > ZSSC3218 Evaluation.*

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* I^2C™ is a trademark of NXP.

3 Evaluation Kit Hardware

The kit hardware consists primarily of two circuit boards: the ZSSC3218 Communication Board and the ZSSC3218 Evaluation Board. They are connected via the 14-pin ribbon cable. The Communication Board has a USB interface for the connection to the user's computer. The Evaluation Board has a PQFN24 socket where the sample IC (a.k.a. the DUT) must be inserted.

3.1. Communication Board

The ZSSC3218 Communication Board has devices mounted on both sides. The components on the top side of the board generate a stable supply voltage and an optional external programming voltage. See Figure 3.1.

There is a pin header (K10) for using a jumper to select either the I^2C™ or SPI communication protocol for communication with the DUT in the socket on the Evaluation Board (see section 3.3). Jumpers K7, K9, and K11 are not applicable, and the settings shown in Figure 3.1 must not be changed. The ribbon cable connector that connects the Communication Board to the Evaluation Board provides access to all communication signals; e.g., for an oscilloscope probe.

A metal potentiometer can be used to adjust the supply voltage in the typical range from 1.7V to 3.8V. Its initial adjustment on delivery provides a voltage VDD ≈ 2.0V to 2.2V. The intensity of the adjacent LED is proportional to the supply voltage.

See section 3.5 for an explanation of the K5 voltage setting.

Figure 3.1   Components on the Top Side of the Communication Board

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April 1, 2016
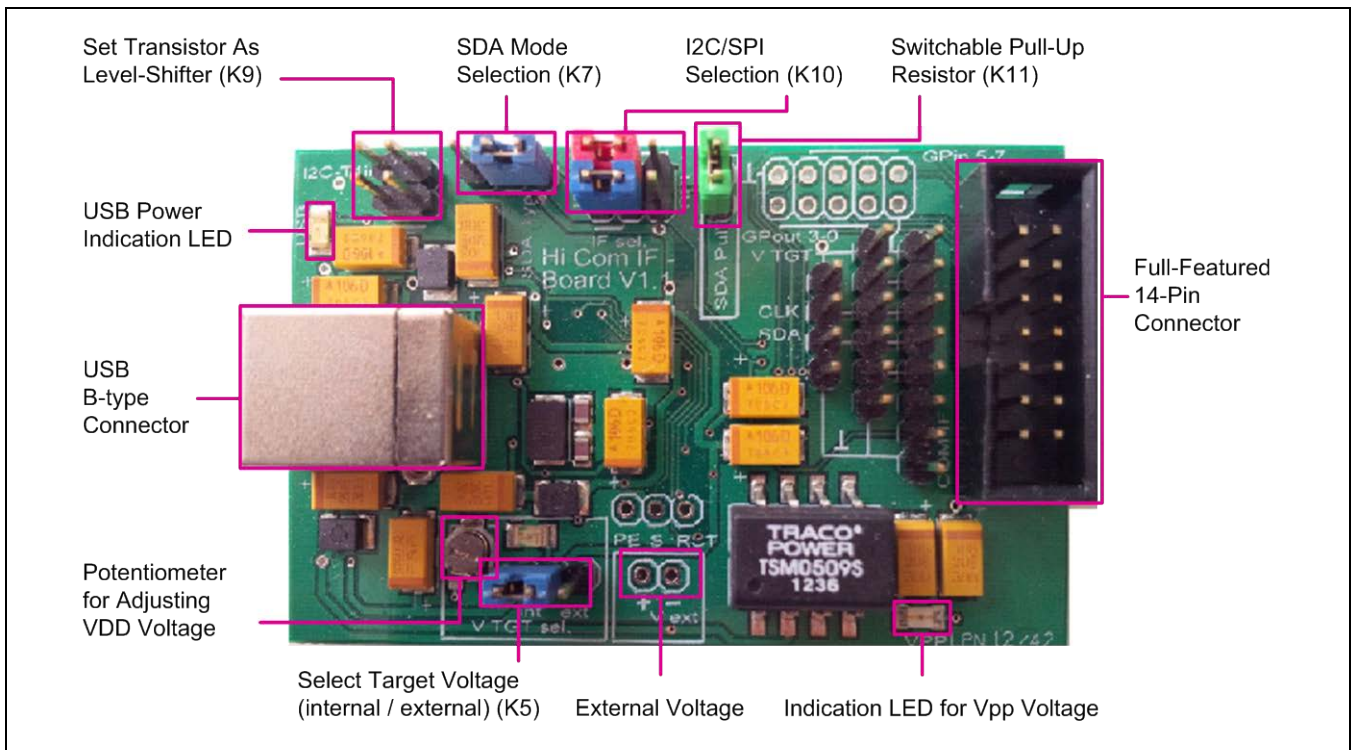
On the bottom side of the Communication Board, the largest IC is the FTDI microcontroller for protocol handling. There are also voltage regulators for the two variable voltages (VDD and VPP) and level shifters for communication signals.

Figure 3.2   Components on the Bottom Side of the Communication Board

.
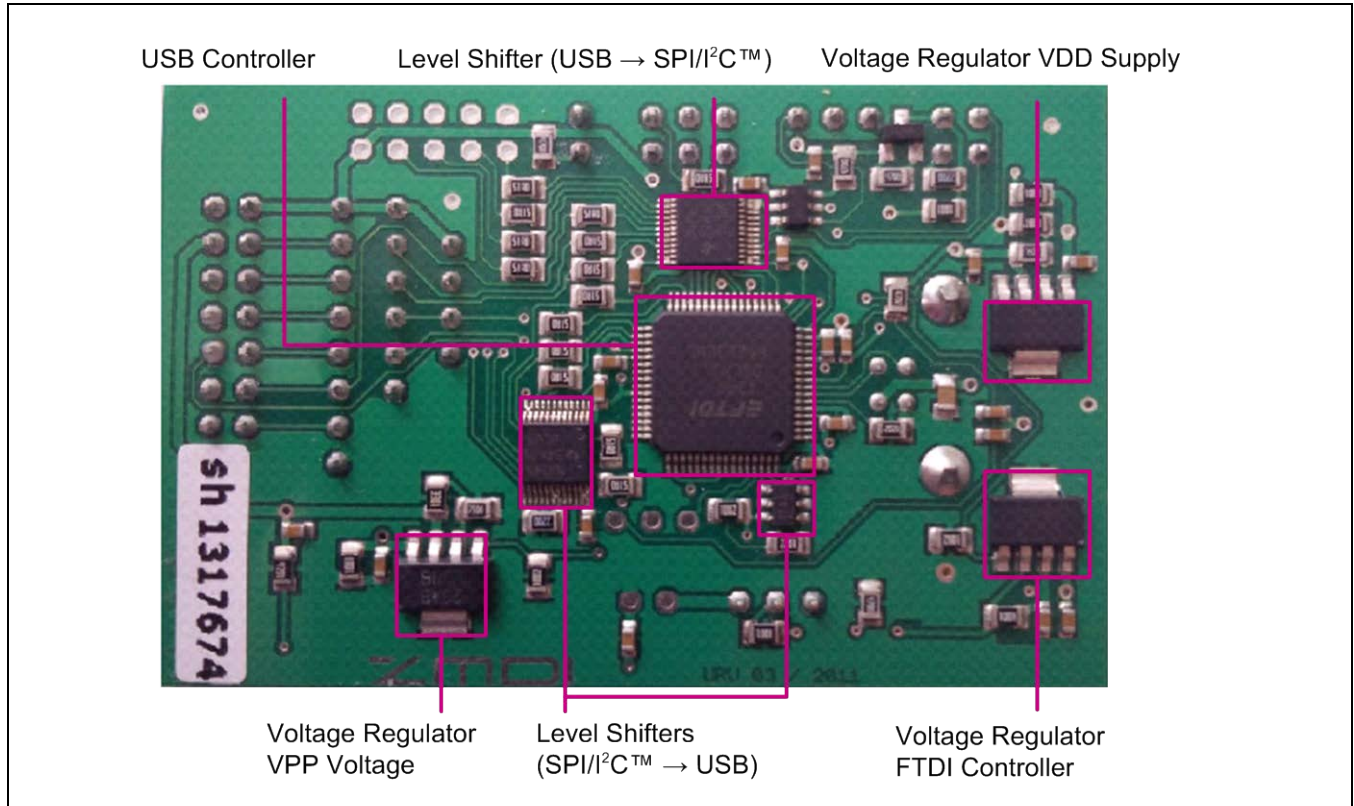
3.2. Evaluation Board

The Evaluation Board provides two alternatives for connecting a sensor or a sensor replacement device: via a 16-pin square sensor connection terminal (K7) or by soldering a sensor with 4 pads on it to an SMD footprint (see Figure 3.3).

The pin header blocks (K1 and K2 with 4 pins x 9 pins) adjacent to the DUT socket allow using a 2-pin jumper to connect signal lines of the DUT (either of the 2 middle pins in each row of each header block) to either VSS (the GND trace pin adjacent to the DUT) or VDD (the outer V_TGT trace pin, which is the supply voltage generated from the Communication Board).

Note: Refer to the schematic in Appendix B and to the pin assignments for the PQFN24 in the *ZSSC3218 Data Sheet* to correlate the labels for the K1 and K2 lines with the actual ZSSC3218 pins.

To connect the proper supply required for the DUT, use the red jumper to connect the DUT's VDD signal line to the V_TGT line as shown in Figure 3.3. Use the blue jumper to connect the DUT's VSS pin to the GND line.

Figure 3.3   ZSSC3218 Evaluation Board
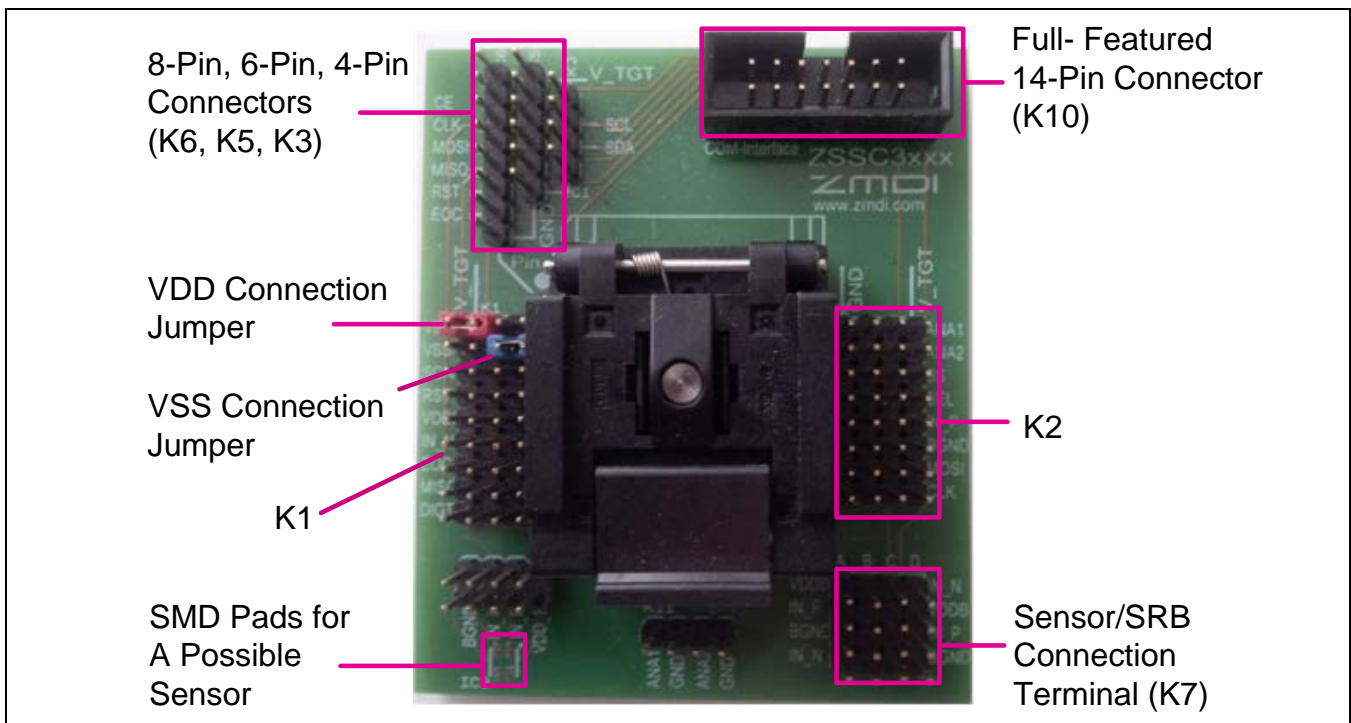
3.2.1. IC Orientation for ZSSC3218 Socket

Ensure that the DUT is properly installed in the PQFN package socket before applying power to the kit. Figure 3.4 shows the proper orientation for the DUT in the socket.

Figure 3.4 Orientation of the PQFN in the Socket
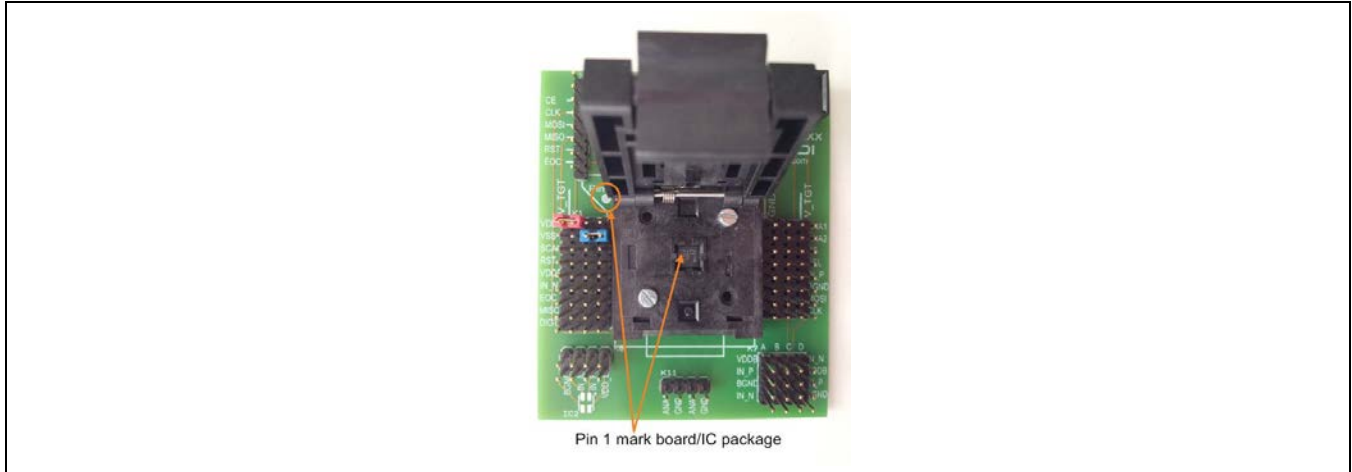
3.3. Interface Choice

Depending on the desired communication protocol the following hardware and software settings are necessary. Jumpers on the Communication Board must be set as shown in Figure 3.5 depending on the interface selection. Refer to the schematics in Appendix A and Appendix B for more details about the signal path.

Figure 3.5 Communication Interface Choice
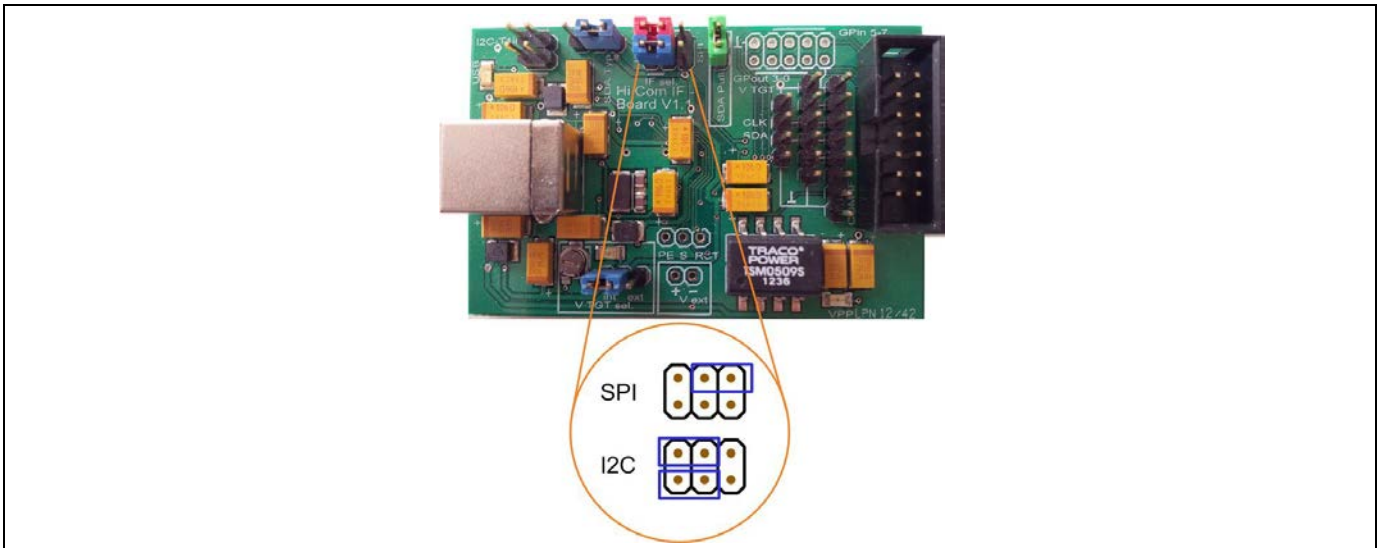
On the Evaluation Board no jumpers are needed. The DUT recognizes the communication interface by the signal activities on the respective signal lines. After the power-up sequence, activity on the MOSI/SDA, SCLK/SCL, and SS lines is generated by the Evaluation Software, which must match the jumper setting on the Communication Board. The default interface of the Evaluation Software is I^2C™. The interface can be changed to SPI via the *Menu bar > Interface Setup > Interface Type > SPI.*

- If the first command is an I^2C™ command and SS pin has been inactive until receiving of this command, the DUT enters the I^2C™ mode.
- If the first interface action is to set the SS pin to active (whether it is active-high or active-low depends on the SS_polarity setting stored in register 02_{HEX} in the DUT's memory), then the DUT enters SPI mode.

3.4. Connectors

The connectors on the CB and EB are labeled. When the ribbon cable is connected (see proper orientation in Figure 2.1), it provides all possible signals between the microcontroller on the CB and the DUT on the EB. The minimum signals required are VDD, VSS, SDA, and SCL; these lines can provide all options for measurements and I^2C™ communication.

Note: The signal names on the CB and EB do not match for some signals; nevertheless the actual signals are provided at the same pins at the corresponding connectors.

Figure 3.6 shows the pin assignment for the available connectors at the CB.

Figure 3.6   Connectors and the Pin Assignments at the CB
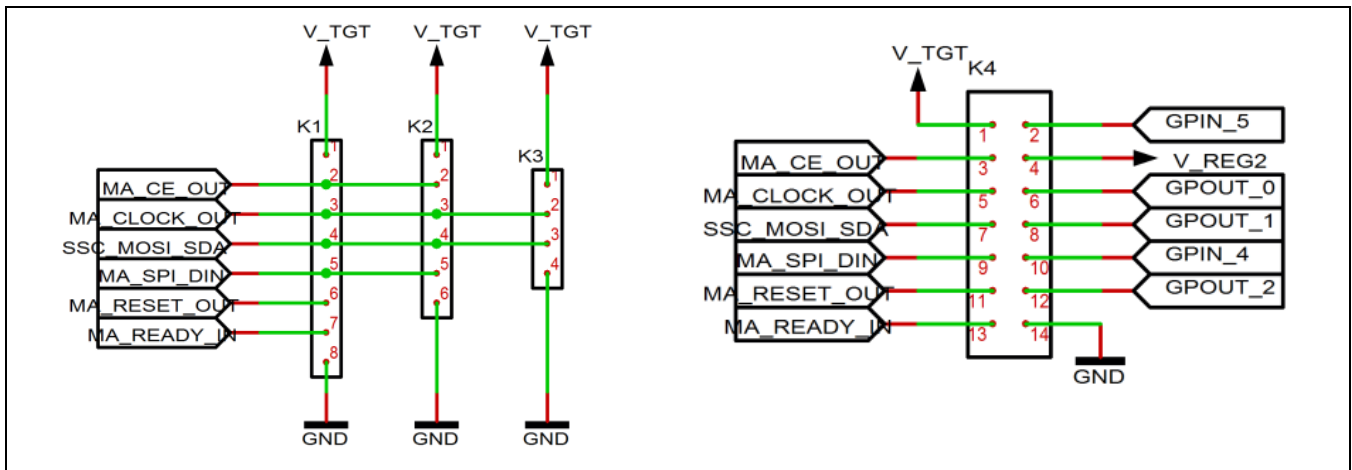
Figure 3.7 **Connectors and the Pin Assignments at EB**
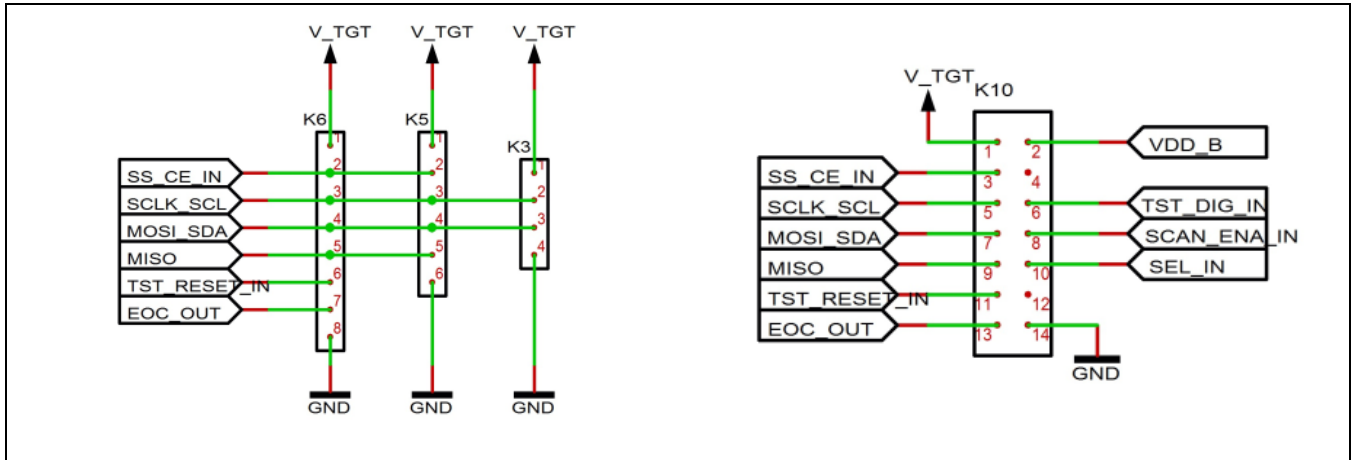
3.5. Supply Voltage

The Evaluation Kit can be powered with an internal or external voltage supply for the DUT on the Evaluation Board, which must be selected with the jumper on the K5 pin header on the CB (see Figure 3.8). There are no settings for selecting the supply source on the EB.

3.5.1. Internal Supply Voltage

The internal VDD supply is generated by a regulator circuit on the CB. It can be adjusted with the potentiometer (see Figure 3.1) in the specified supply voltage range. It is used as the HIGH-level reference for all signals that are needed for communication with the DUT. If the red jumper on K5 on the CB is positioned as shown in Figure 3.8 ("int" setting), then the DUT on the EB is supplied internally. With this setting, no external voltage input is needed for the Evaluation Kit.

Figure 3.8 **Jumper Settings on Communication Board for Internal Supply Voltage**
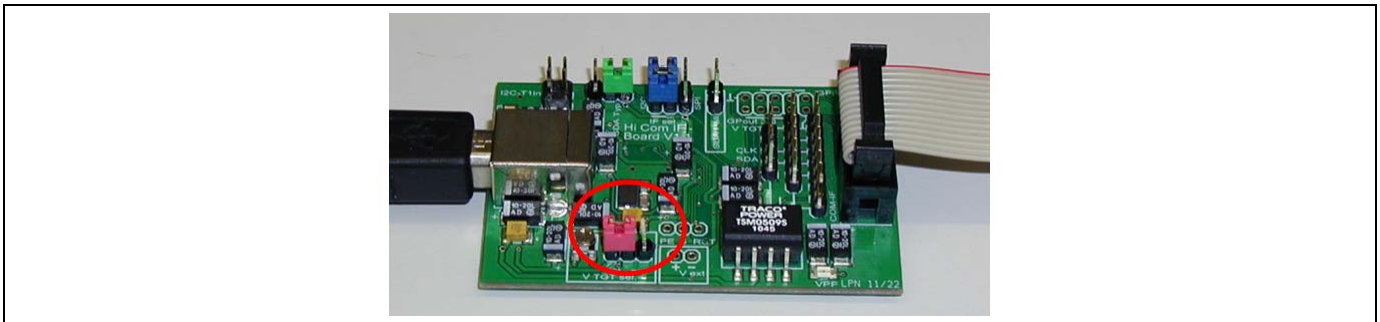
3.5.2. External Supply Voltage

An alternative for providing the supply voltage to the DUT is to input an external voltage supply source. Ensure that the external voltage does not exceed the voltage supply specifications given in the IDT data sheet for the DUT before connecting to the Evaluation Kit.

To use an external supply, set the K5 jumper as shown in Figure 3.9 ("ext" setting). Connect the external voltage to the 2-pin V_ext header that is immediately to the right of the K5 jumper with the orientation shown in Figure 3.9. There are no adjustments for the external voltage on either the CB or EB.

Figure 3.9   Jumper Settings on the Communication Board for the External Supply Voltage

VSS_ext

VDD_ext
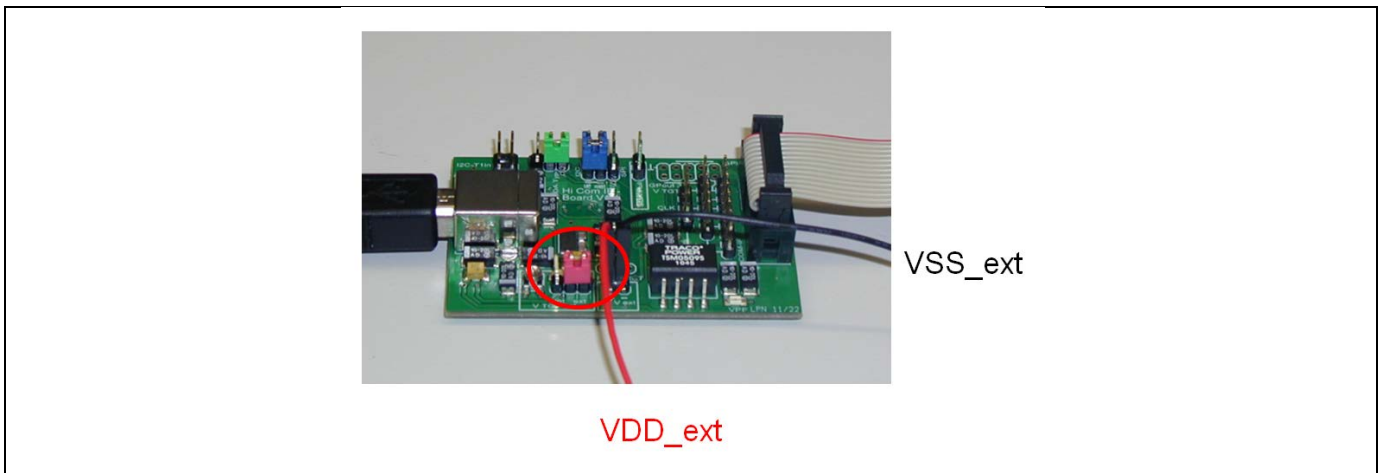
4   Evaluation Kit Software

When the ZSSC3218 Evaluation Software (GUI) is activated, the left side of the first screen is the *General* tab, which provides the basic communication status (see Figure 4.1). The largest section of the screen is the main graph area on the right, which is for displaying the measurement results over time. The data scale for temperature output is on the right side of the main graph; the scale for bridge measurements is on the left. The x-axis represents the number of measurement points at a given value in a run. Both y-axes display the corresponding bridge/temperature value in a format selectable by the user.
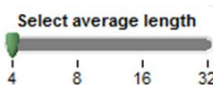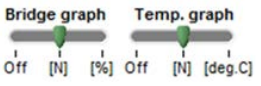
Figure 4.1   GUI View after Opening the Evaluation Software
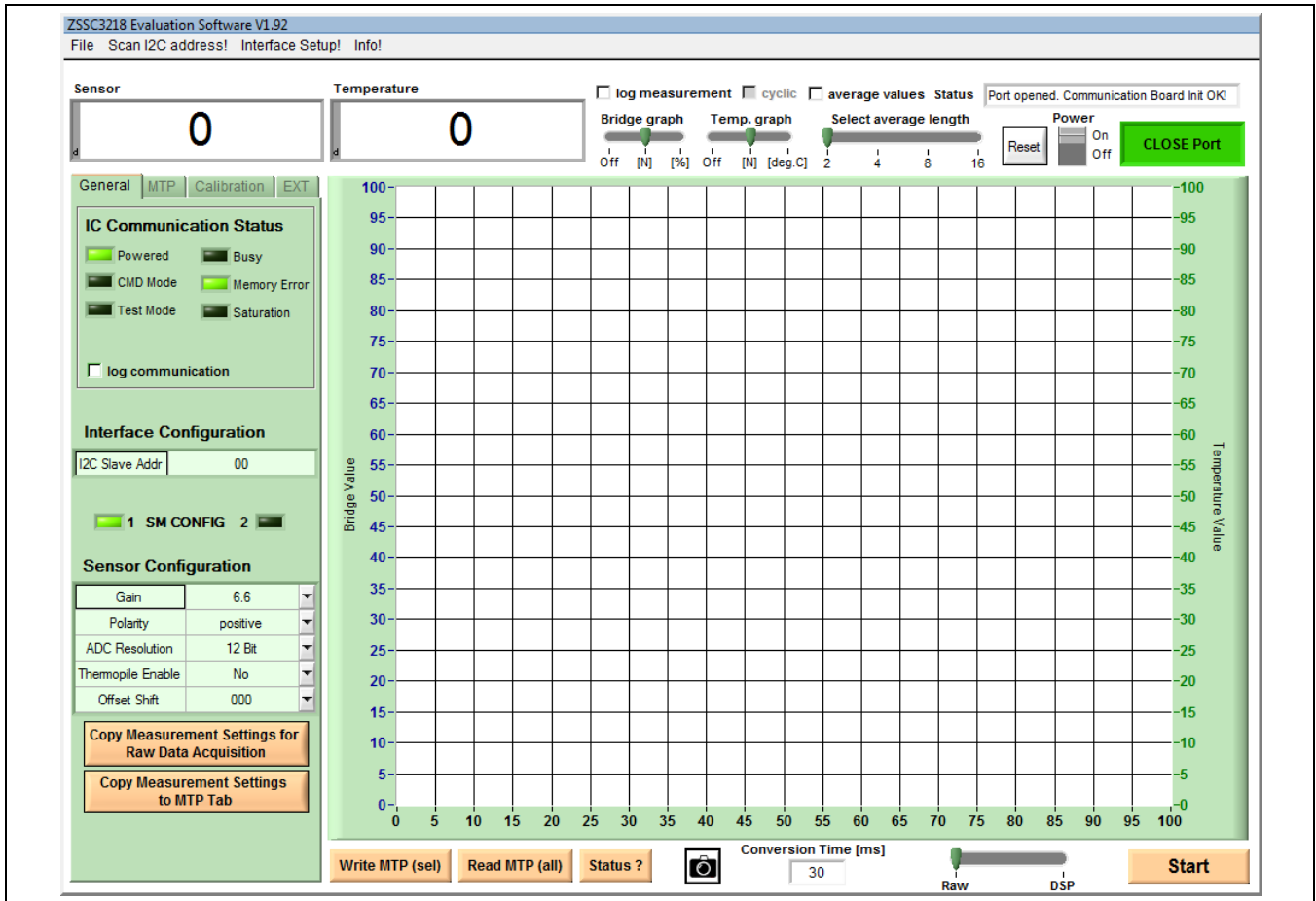
4.1. Top Menu GUI Controls

At the top of the GUI screen is a banner for GUI controls that are always available. These include display fields at the left for real-time single bridge and temperature measurement results. There are also additional controls in the top and bottom sections of the screen as described in Table 4.1.

Table 4.1   Basic GUI Controls

| Control Unit	Description
CLOSE Port *Port* button	The *Port* button allows closing and opening the USB communication port. This is useful for making hardware changes (e.g., switching the DUT or jumper settings) without exiting the GUI. It also indicates the current status. The button is green only if proper communication has been established.
Status display field	The *Status* display field shows information related to the current GUI operation; e.g., if calculated coefficients exceed the defined limits, the *Status* field displays the error.
Power On Off *Power On/Off* icon	The *Power On/Off* icon indicates whether the supply voltage is applied to the DUT in the socket on the EB.
Reset	The *Reset* button triggers a HIGH-LOW-HIGH-transition (active-low reset) at the RES pin. Clicking this button completely resets the DUT.
☐ average values *average values* checkbox Select average length 4 8 16 32 *Select average length* slider	Checking the *average values* checkbox activates averaging of the measurement results. The *Select average length* slider determines the number of measurements that are taken to calculate the average result, which will then be displayed in the display fields for measurement results and on the main graph. Averaging extends the time until the results appear in the GUI by the factor of adjusted average values. The results are displayed in color instead of black font.
Bridge graph Temp. graph Off [N] [%] Off [N] [deg.C] *Bridge graph / Temp. graph* slider bars	The output type for measurement results can be chosen or the associated graph can be switched off with the *Bridge graph* and *Temp graph* slider bars. Raw measurements are only provided in counts. After calibration, the °C and % displays are available. [N] – Displays measurement results in counts. [deg. C] – Displays measurement results in degrees Celsius. This option is only available in Normal Mode where the measurements are linearized by coefficients. [%] – Shows measurement results in percent in relation to full-scale output (FSO = 2^R-1, where R is the ADC resolution in bit). Off – No display of results for the associated graph.

Control Unit	Description
Start	This button activates a cyclic bridge and/or temperature measurement. The measurement mode is defined by the *Raw /DSP* measurement mode slider to the left of this button. See Table 4.5 for a description of the raw data measurement mode and the digital signal processing (DSP) signal conditioning measurement mode.
	In DSP measurement mode, it is also possible to check the *cyclic* checkbox on the top of the GUI. This will start a loop of full-measurement cycles, where the ZSSC3218 internally triggers the measurements as it is configured in the *Interface Configuration* register (02$_{HEX}$), which is described in section 4.3.3.
Raw /DSP measurement mode slider	This slider selects either the raw data measurement mode or the DSP signal conditioning measurement mode. Raw measurements must be configured either via the *EXTERNAL CONFIGURATION* section on the *EXT* tab (see section 4.7) in the panel on the left or by directly writing a configuration into the selected *SM_configX* register (see the *ZSSC3218 Data Sheet* for details). The raw data output provides the results directly after the analog-to-digital conversion (ADC).
	The DSP position selects the configuration from the selected *SM_configX* register for the measurement. The digital result after the ADC will be then processed using the calculated coefficients. This measurement mode will provide valid results only after a valid calibration of the ZSSC3218.
Cyclic checkbox	This checkbox sets the measurement command to *Measure_Cyclic* (AB$_{HEX}$), which executes a continuous full measurement cycle (AZSM, SM, AZTM and TM). In this mode, the ZSSC3218 internally triggers the measurements, so it is only necessary to periodically read the output registers.
	Note: Using cyclic measurements results in a continuous BUSY status (see "Status?" below). The bit is set to '1' until the *STOP_CYC* (BF$_{HEX}$) command is sent. Cyclic measurements can have different properties; the configuration can be set in the *Interface Configuration* register 02$_{HEX}$.
Conversion Time	This entry field is read by the software and used to define the delay after the measurement command before sending the reading request. It can be changed by the user. This period is defined by the conversion time of the ADC, the ZSSC3218 processing time, and the communication time between master and slave. Depending on the resolution settings, the conversion time can vary significantly. The default value of 30ms suffices to establish an auto-zero-corrected measurement with the default 18-bit resolution for the external sensor and 16-bit resolution for the internal temperature measurement. The conversion time can be derived from the ADC conversion time specifications given in the *ZSSC3218 Data Sheet*.
Status ?	This button requests and reads the ZSSC3218's status byte and displays the result on the LEDs on the *General* tab.
Read MTP (all)	Reads the complete contents of the multiple-time programmable (MTP) memory of the ZSSC3218. The decoded basic bridge configuration and the I^{2}C™ address are displayed on the *General* tab.
Write MTP (sel)	This button activates writing to the MTP of the ZSSC3218. It writes only the addresses for which the content is shown in red font on the *MTP* tab (see section 4.6). In addition to using the automatic data transfer from the *Calibration* tab and *General* tab, users can also edit the values by double-clicking on the value on the *MTP* tab page. The ZSSC3218 must be in Command Mode (CM) in order to write to the MTP; therefore the software performs a power-on >power-off >*Start_CM* sequence in the background. After the write operation, the ZSSC3218 will be set into Normal Mode again.

4.2. Measurement Color Code

Bridge and temperature results are displayed in different colors. Different colors are also used for single and averaged measurement results as defined in Table 4.2

Table 4.2   *Color Code for Bridge and Temperature Results*

Color	Indication
Pink	Single bridge measurement.
Light Blue	Single temperature measurement.
Blue	Averaged bridge measurement.
Green	Averaged temperature measurement.
Red	Invalid measurement result. This could be due to a *Conversion Time* that is too short. In this case, bit 5 in the status byte is set to '1' and the *Busy* virtual LED on the *General* tab turns on. Another reason for an invalid measurement result could be if saturation of the arithmetic logic unit (ALU) is detected. In this case, the *Saturation* LED turns on.

4.3. GUI Menu Bar

Figure 4.2 shows the submenu, dialog, and informational items accessible via the top GUI menu bar.

Figure 4.2   *Structure of the GUI Menu Bar*
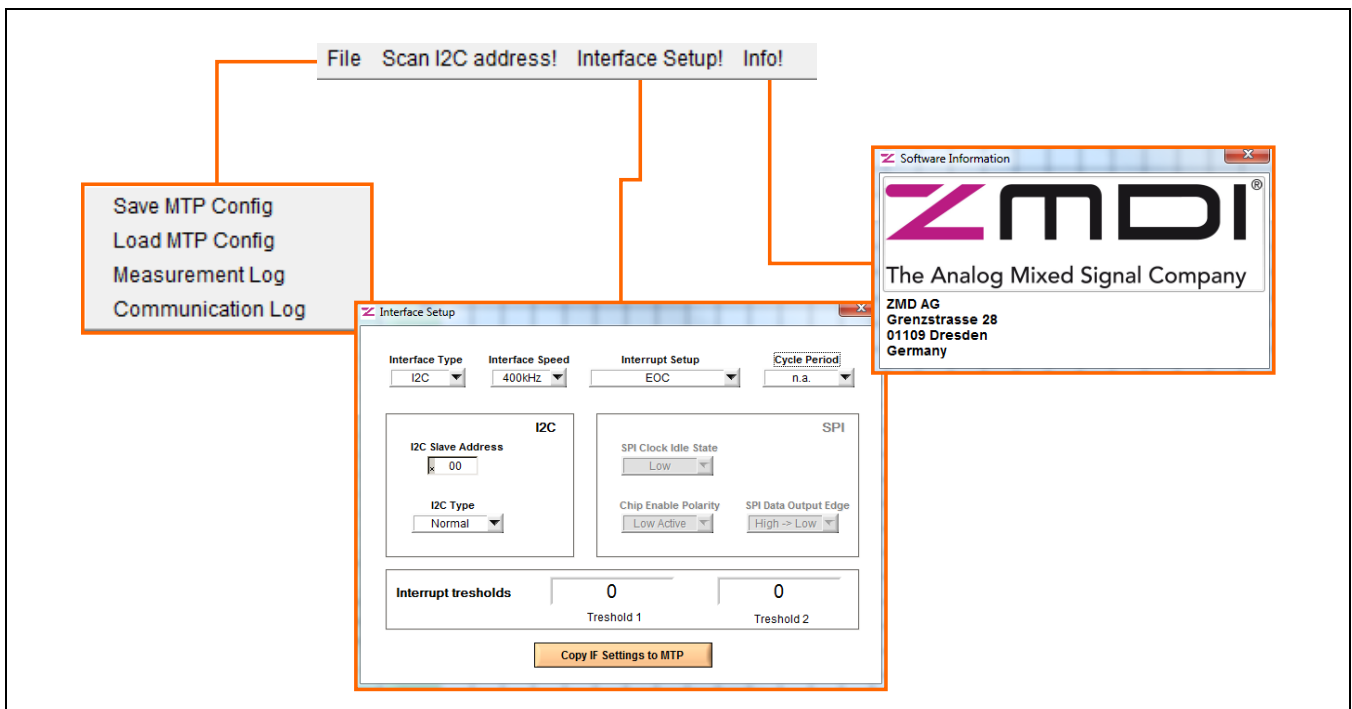
4.3.1. Save/Load MTP Register Contents

Initially, the customer memory pages are empty. If an identical memory configuration is needed for multiple ICs, it is possible to save a given setup as a template. When the required MTP content is present in the *MTP* tab, select *File > Save MTP Config.* The configuration file is created with an *.eep* extension, and it contains one decimal value for each MTP address in each row.

To load a configuration file, select *File > Load MTP Config.* Note: The decimal values will be automatically displayed as hexadecimal values in the *MTP* tab. The loaded configuration data is displayed in red font in the *MTP* tab and can be written into the memory.

4.3.2. Scan I^{2}C™ Bus via the *Scan I2C address!* Feature

Another feature provided in the menu bar is the ability to scan the I^{2}C™ bus to determine the I^{2}C™ address of the ZSSC3218. Selecting *Scan I2C address* triggers the scan during which the ZSSC3218 status is requested for each address ranging from 00_{HEX} to $7F_{HEX}$. When an I^{2}C™ address is acknowledged by the ZSSC3218, the scan stops, and this address is used for further communication during the current GUI session. The results of the scan are indicated in the status window:

- Status window message for a successful I^{2}C™ scan: Valid I2C address found: 0xXX!
- Status window message for an I^{2}C™ scan without slave acknowledge: No valid I2C address found!

The I^{2}C™ address information is lost if the GUI or the communication port is closed. Communication to the ZSSC3218 with an I^{2}C™ address other than 00_{HEX} can also be established by entering it manually in the *Interface Setup* dialog accessible via the top menu bar by selecting *Interface Setup* and entering the hexadecimal address in the *I2C Slave Address* field.
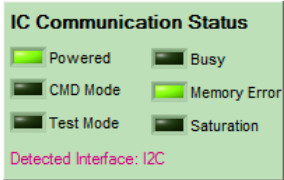
4.3.3. Interface Setup Dialog
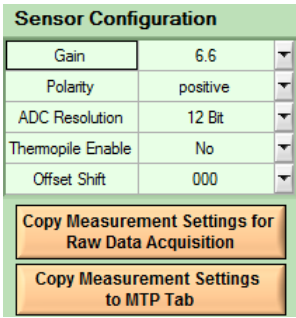
The interface setup dialog allows the general choice between the I^{2}C™ and the SPI interface. After an interface is selected, the software generates the corresponding data frame structure which is then recognized by the ZSSC3218. All parameters in the upper row (Interface Type, Interface Speed, Interrupt Setup, and Cycle Period) and the I2C/SPI specific settings in the corresponding section are parameters from the *Interface Configuration* register (02_{HEX}). The lower part of the window displays the selectable lower and upper threshold values for the interrupt configuration (see *ZSSC3218 Data Sheet* for details). Enter the values in the decimal representation.

Modifications entered in the dialog are valid for further communication after this window is closed. To save the changes in the ZSSC3218's memory, adjust the parameters as needed and click the *Copy IF settings to memory* button to transfer it to the *MTP* tab in the GUI. As a result, the registers 02_{HEX} *(Interface Configuration)* and/or registers 13_{HEX}, 14_{HEX}, and 15_{HEX} (interrupt thresholds) appear red if their content changed. Then click the *Write MTP (sel)* button on the *MTP* tab to write the new content into the memory.

4.4. GUI – *General* Tab

Table 4.3   General Tab –Displays and Controls

| Control / Display Unit	Description
IC Communication Status Powered Busy CMD Mode Memory Error Test Mode Saturation Detected Interface: I2C	The communication status section evaluates the status byte information sent from the sample. It provides following information via the virtual LEDs: **Powered** indicates if the device is powered. If the LED is off, it does not automatically mean that VDD is not supplied. For example, the LED will be off if the I^{2}C™ communication is attempted with an I^{2}C™ address different from the address programmed in the ZSSC3218's memory. **CMD Mode** shows whether the ZSSC3218 is in Command Mode. **Test Mode** shows whether the ZSSC3218 is in Test Mode (not intended for users) **Busy** indicates if processing of the last command is finished. If it is, the LED is off. Note: the LED will be on continuously if the ZSSC3218 is in a cyclical measurement mode. **Memory Error** displays whether the checksum-based integrity check passed or failed. In the default state of the kit, this LED should be on. Recommended approach: After writing memory data (e.g., bridge configuration, coefficients), write the signature of the memory contents via the *Write Checksum to MTP (register 0x39)* button on the *MTP tab*. After a subsequent power-on-reset sequence, the integrity check should pass and the LED should turn off. **Saturation**: This LED is on if the DSP core saturates; e.g., if the internal signal correction result exceeds the limits of the internal arithmetic logic unit (ALU).
log communication Checkbox ☐ log communication	For some purposes such as debugging or documentation, it is helpful to log the master-slave communication. To record this data, activate this checkbox, which results in a dialog window for selecting the name and location for a *.txt* file where this information will be written. After the *.txt* log file is set up, it can be opened via the menu bar: *File > Communication Log.*
Interface Configuration I2C Slave ADR 00	After reading the MTP, the display shows the I^{2}C™ address that is saved in the memory. If a new address is entered in the window and the *Copy Measurement Settings to MTP* button is clicked, the new value is shown in red color on the *MTP* tab.
1 SM CONFIG 2	Depending on which configuration register is selected, LED 1 or 2 on the *General* tab is green. This information is obtained from the ZSSC3218's status byte where bit 1 (*Config Setup*) identifies the valid configuration register. Command B0$_{HEX}$ selects the *SM_config1* register for sensor measurement configuration; command B1$_{HEX}$ selects the *SM_config2* register. See Figure 4.3 for further details.

Control / Display Unit	Description
Sensor Configuration **Sensor Configuration** Gain — 6.6 Polarity — positive ADC Resolution — 12 Bit Thermopile Enable — No Offset Shift — 000 **Copy Measurement Settings for Raw Data Acquisition** **Copy Measurement Settings to MTP Tab**	The *Sensor Configuration* area provides settings for the analog signal path and analog-to-digital conversion. The drop-down menus contain the available setting values. Changing the parameter values here does not automatically apply them to measurements. It is possible to apply the adjusted settings and use them for raw data collection. There are different commands for performing raw measurements. Some of the commands use the configuration from the *SM_config* register (commands A0$_{HEX}$, A2$_{HEX}$); others (A1$_{HEX}$, A3$_{HEX}$) are configured via the interface. For a full description of raw measurement commands, refer to section 4.7.1. For configuration via the interface, click on the *Copy Measurement Settings for Raw Data Acquisition* button, which automatically displays the EXT tab (see section 4.7) and transfers the present settings to the external configuration section. The *Copy Measurement Settings to MTP Tab* button copies the present settings to the MTP tab. The settings can then be written to the MTP memory (see section 4.6).

4.4.1. Using Two Configurations for One Sensor

For users who consider using one sensor for different applications, there are two configuration registers available. This might be useful, e.g., for thermopile applications where two different object temperature ranges should be covered with only one sensor-ZSSC3218 combination, in which case it is primarily the analog gain parameter that will have different values. The ZSSC3218 supports this type of function. The selection of the SM_configX register is not mandatory. If no active SM_configX selection is executed, SM_config1 is used for configuration. To apply the configuration of the second configuration register, it is necessary to send a command that selects it. Once a register is selected, its configuration is valid as long as VDD is on or until there is a reset or a command to select the other register. The following graph shows the possibilities for handling two configurations.

Figure 4.3   Selection of the SM_config1 or SM_config2 Register
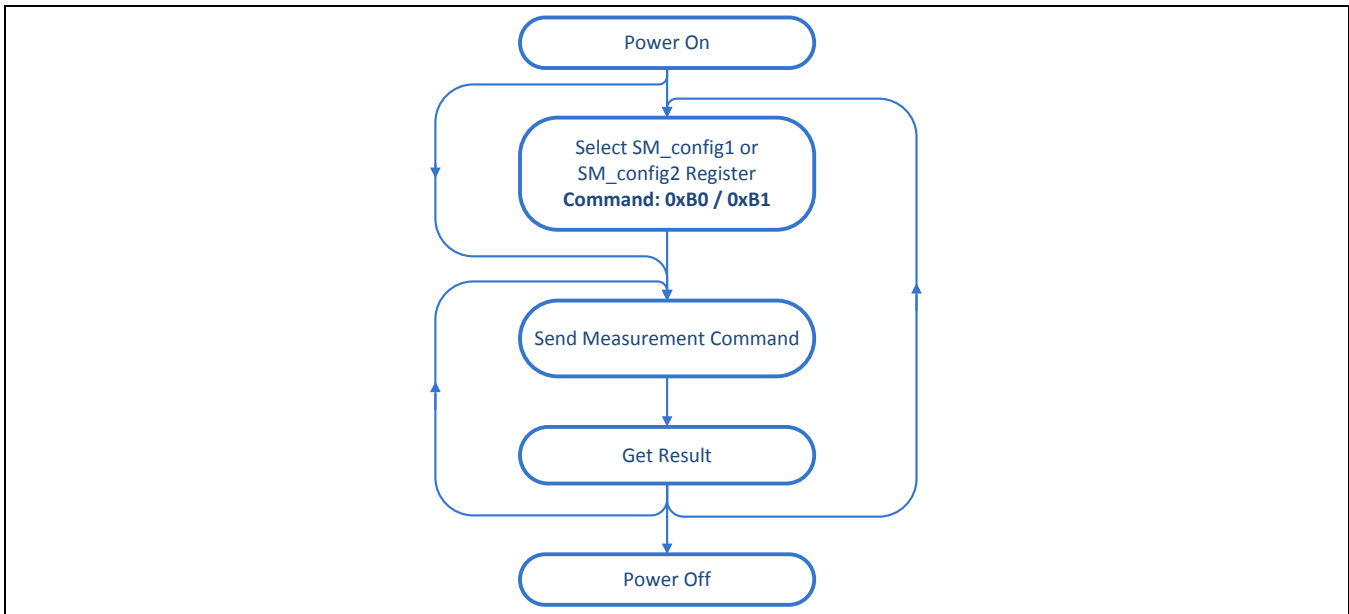
4.5. Data Logging

The ZSSC3218 Evaluation Kit software provides the option to log measurement and communication data as described in Table 4.1 and Table 4.3.

4.5.1. Communication Log

Communication with the ZSSC3218 can be logged for both the I^2C™ and SPI interface. Click on the *log communication* checkbox on the *General* tab to activate recording the data stream. Choose a file path for which the user has writing permission for storing the log file. Open the log file via the top menu bar: *File > Communication Log.* The resulting text file is an ASCII file that can be imported into Microsoft® Excel.

4.5.1.1. I^2C™ Log

Figure 4.4 shows a short example of the I^2C™ communication recorded in a log file.

Figure 4.4 I^2C™ Communication Example

```
log I2C interface...
data frame  00  a3  0b  26          end
data frame  01  44  8c  87  c0      end
data frame  00  a6  00  00          end
data frame  01  44  cb  1b  80      end
log end
```

The log file maps only the transferred data, not the specific frame conditions for I^2C™, such as START or STOP conditions or acknowledges. Communication commands that are not available to the user are not logged. This also applies to the SPI communication log.

By default, the READ data from the slave has a 4, 5, or 8 byte structure. In the example shown in Figure 4.4, a raw bridge measurement is done in two steps:

Figure 4.4 shows an example for a raw bridge and temperature measurement sequence:

- Raw bridge measurement ($A3_{HEX}$). Sent to the device with the I^2C™ address 00_{HEX}, with configuration transmitted in the following bytes after the command (via interface). The next row shows the read data frame from the slave to master.

- Raw temperature measurement ($A6_{HEX}$). Sent to the device with the I^2C™ address 00_{HEX}. This command triggers the ZSSC3218 to obtain the measurement configuration from the corresponding configuration register. Thus the data that comes after the command byte does not have any impact on the measurement processing. In the next row the ZSSC3218 is providing status and measurement result.

The I^2C™ interface properties correspond to the NXP I^2C™ bus specification. For the I^2C™ log example data, the sections of the data frame structure are explained in Figure 4.5. In this illustration for communication frames, START conditions are indicated with S; STOP conditions are shown as P; and acknowledges are shown with A. For information about communication frame structure, see the data sheet (see section 3.5.3.).

Figure 4.5 *I²C™ Communication Structure for Example Entry in Communication Log*
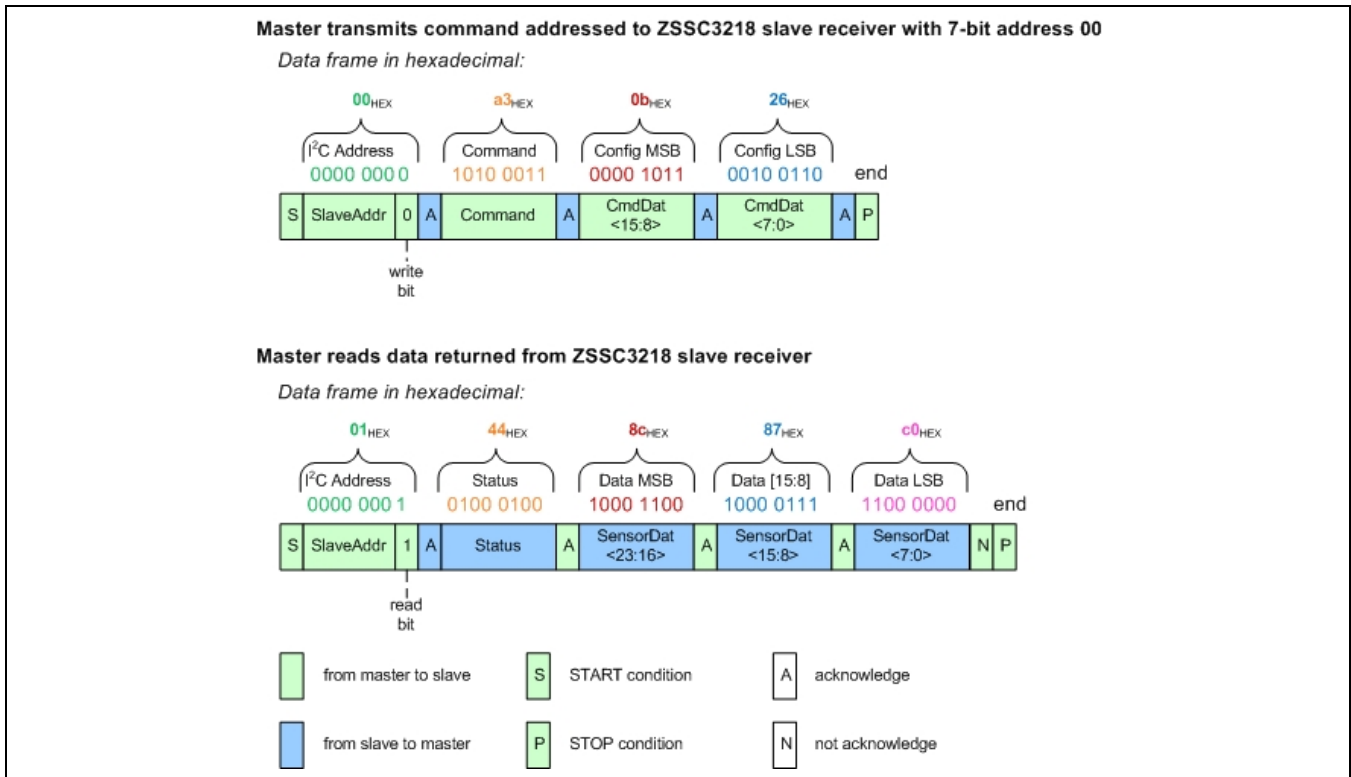
4.5.1.2. SPI Log

Communication via SPI is accomplished via the ZSSC3218's MOSI pin for input and the MISO pin for output. The MOSI data always consists of 3 bytes; MISO data is 3 bytes long for register reading, 4 bytes long for raw measurements and 7 bytes long for full measurement commands. The example shown in Figure 4.6 has the same command sequence as the I²C™ example, with other measurement results values. The difference is the $F0_{HEX}$ command, which is sent by the Evaluation Software before reading the MISO signal. This is due to IDT's hardware/software setup for the kit. It is not required for the final user application.

Figure 4.6   SPI Communication Example

```
log SPI interface...
MOSI    a3   0b   26            end
MOSI    f0   00   00            end
MISO    44   86   99   20       end
MOSI    a6   00   00            end
MOSI    f0   00   00            end
MISO    44   dd   29   80       end
log end
```

4.5.1.3. Measurement Log

Measurement data can also be recorded in the measurement log file by clicking on the *log measurements* checkbox in the top section of the GUI. In raw measurement mode, the results are logged in counts; they are not calculated as a percentage (external sensor) or degree Celsius (internal temperature sensor). If the ZSSC3218 is calibrated, the DSP-corrected external sensor results are provided in counts and percentage based on the output range and the temperature results are logged in counts and degree Celsius numbers.

The measurement log file is accessed via the top menu bar by clicking *File > Measurement Log*.

4.5.1.4. Measurement Results Presentation

As described in the previous section, measurement results are displayed in the numerical displays on top left and in the main graph, where their history can be tracked. Both presentations are adjusted to the resolution that is configured for the particular measurement; e.g., if executing an external sensor measurement with a resolution of 18 bits, the GUI will show a digital output with a minimum input of -131071 and maximum output of 131072 counts.

Basically each measurement result coming from the ZSSC3218 is structured in 3 bytes (24 bit). The GUI limits the data display to the selected resolution via software. The origin stream of bits can be viewed by logging the communication. The following graph is an example of both the output adjusted for the resolution setting in the GUI and the appropriate data in the communication log.

Figure 4.7 Display of Measurement Results
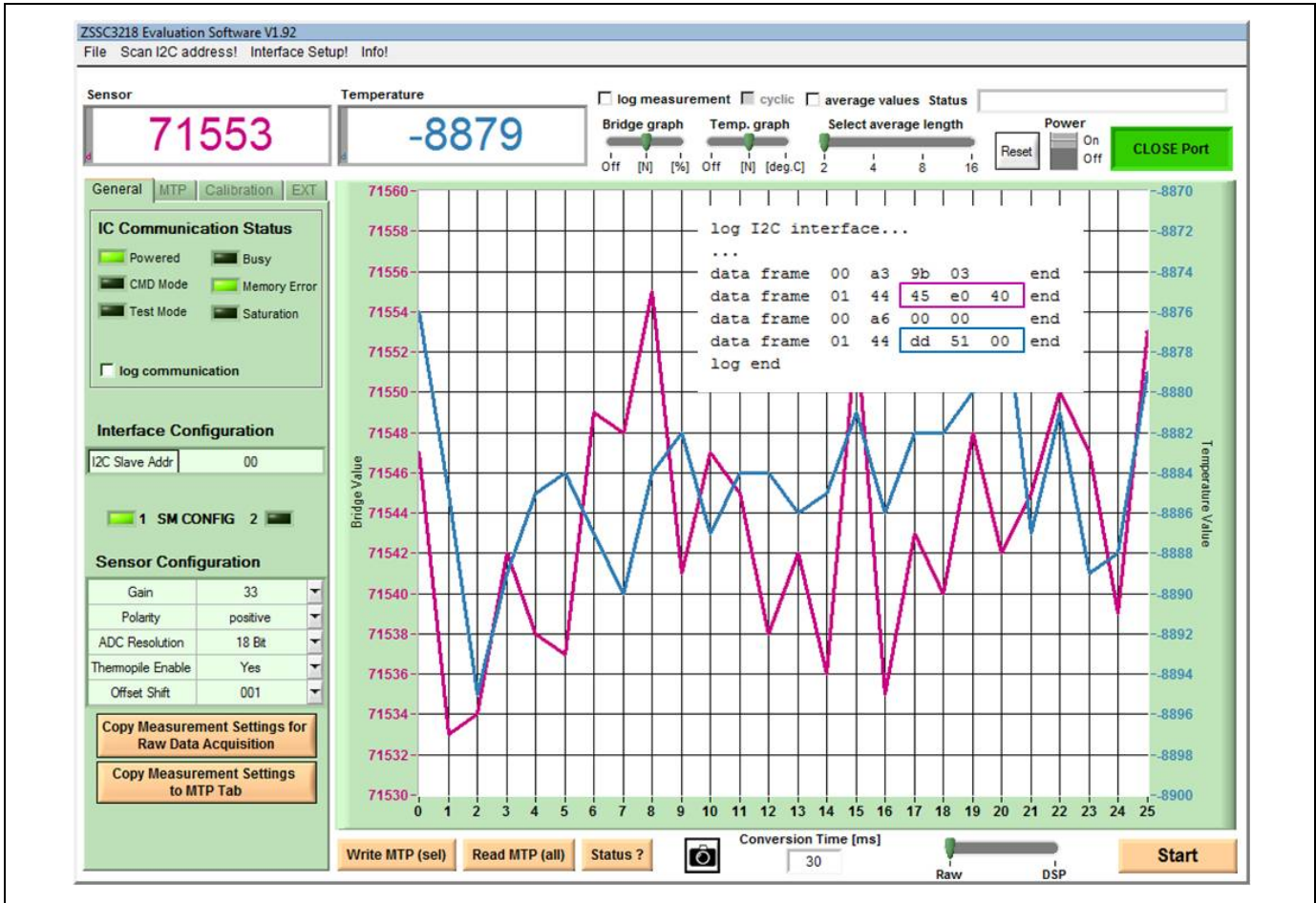
The GUI shows results in the standard signed decimal output. For the example shown in Figure 4.7, the results are as follows:

External Sensor Output (GUI): 77553_{DEC}

Internal Temperature Sensor Output (GUI): -8879_{DEC}

In the example log file for that measurement, the last entry is the corresponding 24-bit results in two's complement representation:

External Sensor Output (Communication log): $45E040_{HEX}$

Internal Temperature Sensor Output (Communication log): $DD5100_{HEX}$

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In the example shown in Figure 4.7, the selected resolution for both the sensor and temperature measurements is 16 bit. The conversion from the 24-bit two's complement value to the decimal presentation is shown in the following table.

Table 4.4   Measurement Results Conversion (24-bit two's complement to decimal)

Operation	Sensor	Temperature	Notes
	45E040	DD5100	24-bit two's complement, hexadecimal
>> 6			Shift the external sensor value by 6 bits to the right (convert 24 bits >> 18 bits)
>> 8			Shift the temperature value by 8 bits to the right (convert 24 bits >> 16 bits)
=	11781		18-bit two's complement, hexadecimal
=		DD51	16-bit two's complement, hexadecimal
dec	**71553**	**-8879**	Convert to decimal

The results correspond to the GUI display in Figure 4.7.

4.6. GUI – *MTP* Tab

The *MTP* tab is used to display the current memory data. The data is displayed in four hexadecimal digits for each of the first 20_{HEX} (32_{DEC}) addresses in the MTP. The final register 39_{HEX} (57_{DEC}) contains the checksum of the entire memory contents. To see the registers 19_{HEX} and 39_{HEX}, click on the memory table and scroll down.

To display the memory contents in the *MTP* table, read the complete memory by clicking on the *Read MTP (all)* button. The resulting message in the status window at the top right of the GUI should be *"MTP Read OK."* Subsequent changes in this table are indicated with red font so that the user is aware that the changed data does not correspond with the ZSSC3218's MTP data.

As shown in Figure 4.8, the first column is the address number; the second column comprises the data in the register. The description name for the corresponding register is given in the third column.

Figure 4.8   User-Accessible Memory, Addresses 00_{HEX} through 39_{HEX}
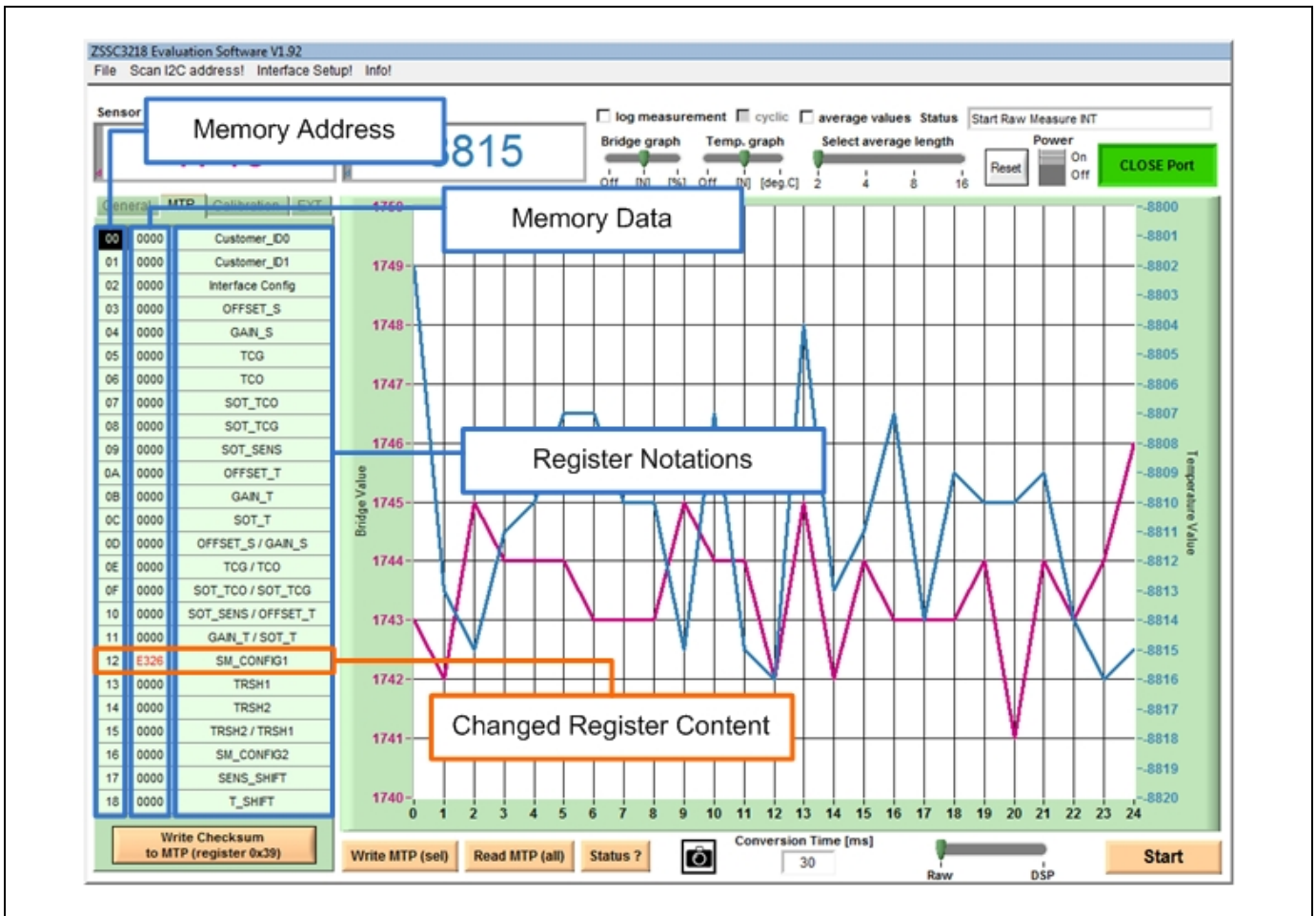
Clicking the *Write Checksum to MTP* (register 39_{HEX}) button at the bottom of the *MTP* tab triggers the signature generation and writing the new signature over the current memory contents for register 39_{HEX}. Therefore it should be the last step to be done after bridge measurement configuration, coefficient calculation, and writing. After the checksum has been written and the ZSSC3218 has been re-powered, the *Memory Error* LED turns off (see Table 4.3).

4.7. GUI – *EXT* Tab

The *EXT tab* is divided into two sections. The upper tab area is for communication with the ZSSC3218 with single commands selectable from the drop-down menu. This section is considered as an additional communication option but it is not necessary for typical user purposes.

The lower part of this tab is relevant for the external bridge configuration and temperature. "External" in this context means that the configuration does not have to be written to the memory. It can be transmitted with the measurement command over the communication interface. All commands defined in the *EXTERNAL CONFIGURATION* section are *Get_Raw* measurement requests.

Figure 4.9   Tab for Externally Defined Communication
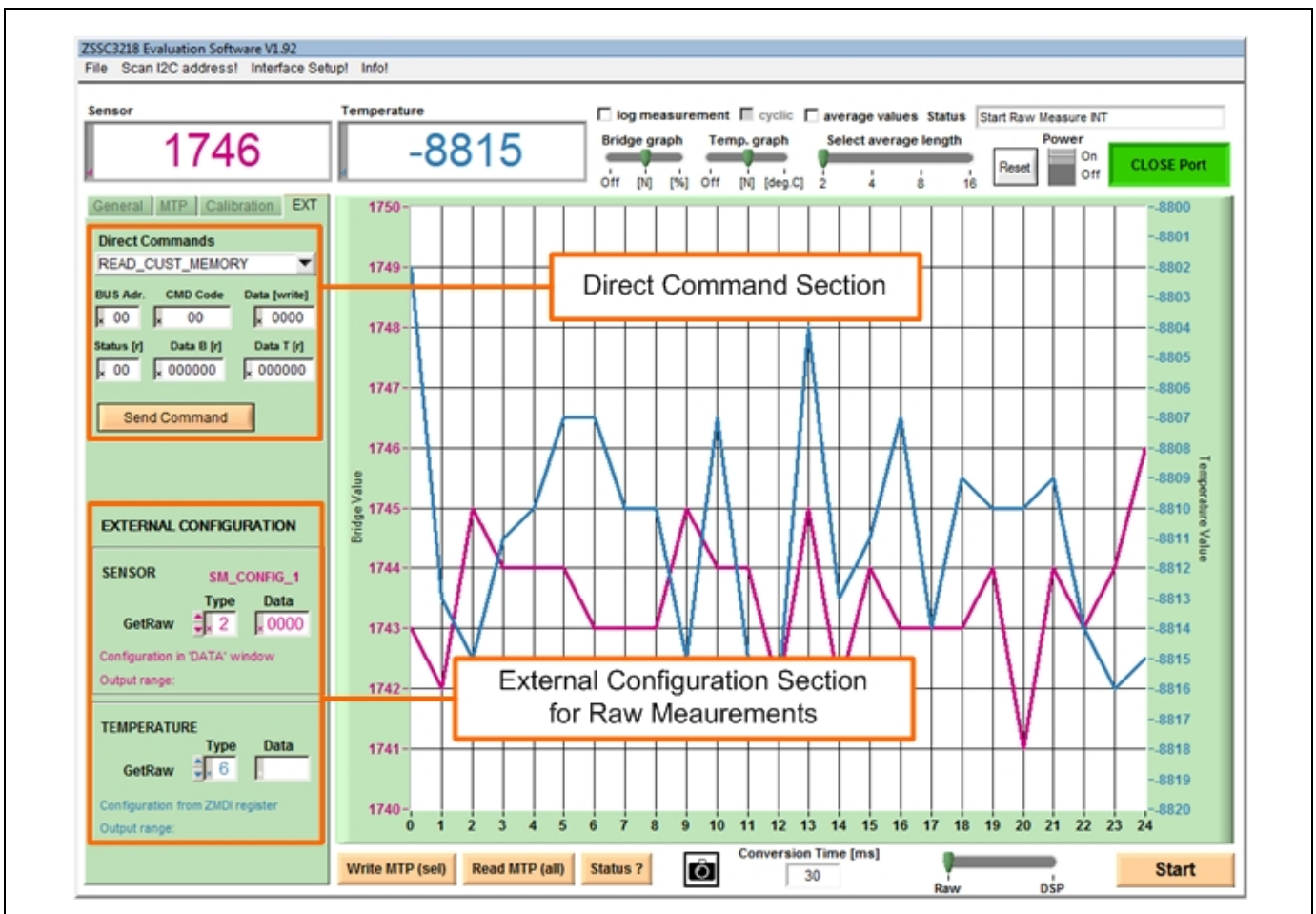
In the "Sensor" and "Temperature" subsections of the *EXTERNAL CONFIGURATION* section, the *Type* window defines the *Get_Raw* command and the *Data* window selects the measurement configuration if required. Refer to Table 4.5 for the descriptions of the possible commands and the data.

Example: In the "Bridge" section, an entry of 3_{HEX} in the *Type* field and 0225_{HEX} in the *Data* field corresponds to the *GetRaw* command A3 0225_{HEX}.

4.7.1. Get_Raw Commands

Eight Get_Raw commands for data acquisition are available, depending on the measurement type and the source of the configuration; however, there are basically only two different commands: the single measurement and the auto-zero measurement, which selects the ADC offset. These are applied to the bridge and temperature measurements with different configuration origins.

All measurement command options are described in the Table 4.5.

Table 4.5   Get_Raw Commands

Command		Measurement	AFE Configuration Register
Type	Data		
$A0_{HEX}$	0000_{HEX}	SM – Bridge Measurement	*SM_config1* register or *SM_config2* register
$A1_{HEX}$	$ssss_{HEX}$	SM – Bridge Measurement	ssss is the user's configuration setting for the measurement provided via the interface. The format and purpose of configuration bits must be consistent with the definitions given for the *SM_configX* register. (See the *ZSSC3218 Data Sheet*.)
$A2_{HEX}$	0000_{HEX}	SM-AZSM – Auto-Zero Corrected Sridge Measurement	*SM_config*
$A3_{HEX}$	$ssss_{HEX}$	SM-AZSM – Auto-Zero Corrected Bridge Measurement	ssss is the user's configuration setting for the measurement provided via the interface. The format and purpose of configuration bits must be equal to the definitions for *SM_configX*.
$A4_{HEX}$	0000_{HEX}	TM – Temperature Measurement	IDT-defined register.
$A6_{HEX}$	0000_{HEX}	TM-AZTM – Auto-Zero Corrected Temperature Measurement	IDT-defined register.

Raw commands with Auto-Zero correction measure the system internal offset and subtract it from the common measurement result.

4.7.2. Data Output Range

Any ADC measurement and its calculated sensor signal conditioned output are formatted as a 24-bit wide data word, regardless of the effective selected ADC resolution. The Evaluation Software reduces the resolution to the resolution configured for the measurement. Table 4.6 illustrates the GUI output ranges depending on the resolution and operation mode. The raw measurement output is the ADC data without passing through the DSP. The current common range is shown in the GUI in the *SENSOR* and *TEMPERATURE* section in the *EXT tab*. Output data in Normal Mode is digitally corrected and adjusted to the full-scale output of the valid resolution if the device has been calibrated correctly.

Table 4.6   GUI Output Ranges

Operation Mode	Numerical Format	ADC Resolution (bits)	GUI Display and Measurement Log	
			Min	Max
Raw Measurement	Decimal	12	-2048 (-2^{11})	2047 ($2^{11} - 1$)
		13	-4096 (-2^{12})	4095 ($2^{12} - 1$)
		…	…	…
		18	-131072 (-2^{17})	131071 ($2^{17} - 1$)
Normal Mode	Decimal	12	0	4095 ($2^{12} - 1$)
		13	0	8191 ($2^{13} - 1$)
		…	…	…
		18	0	262143 ($2^{18} - 1$)
Calibration Table (see section 4.8)	Decimal	12, 13, …18	-8388608 (-2^{23})	8388607 ($2^{23} - 1$)
Measurement log	Decimal	Same as in raw measurement		
Communication log	Hexadecimal Two's Complement	Same as in calibration table		

4.7.3.   Setting up Bridge Configuration for Calibration

If the sensor characteristics are known, the external sensor measurement settings can be defined in the *General* tab.

The following parameters can be configured:

- **Bridge Gain**: The analog gain is applied in two different amplifier stages. The possible gain factors of these two stages are selectable in the drop-down menu. Recommendation: Choose the bridge gain as high as possible in order to take full advantage of the ADC's dynamic range.

- **Bridge Polarity**: The ZSSC3218 has the capability to switch the polarity of the sensor input INP and INN. This setting is only valid if the differential sensor signal has a higher negative voltage output range than the positive one:
  if (abs(V_{max}) < abs (V_{min}))) Bridge Polarity = 1
  else Bridge Polarity = 0

- **Thermopile (AbsV) Enable:** Enable bit for thermopile input selection (INN connected to AGND, INP connected absolute voltage source)

- **Bridge Offset Shift**: Depending on the sensor output, the offset can be adjusted to ADC's input by a programmable offset. The offset can be chosen from 8 different values. For further details, refer to the *ZSSC3218 Data Sheet*.

4.7.4.   Starting External Sensor Measurement

After determining the best fit for the external sensor measurement configuration, it can be applied. Two options are available for raw measurements of an external sensor:

Configuration, transmitted via communication interface:

- ⇨ Adjust settings in the *Sensor Configuration* section *(General tab)*
- ⇨ Click the *Copy Measurement Settings for Raw Data Acquisition* button (General tab)
- ⇨ Choose command Type 0 (command $A1_{HEX}$) or 2 (command $A1_{HEX}$) in the EXTERNAL CONFIGURATION section of the EXT tab.
- ⇨ Activate the measurement with the *Start* button at the bottom of the display.

Configuration, loaded from SM_config1 register:

- ⇨ Adjust settings in the Basic Bridge Configuration section (General tab)
- ⇨ Click the *Copy Measurement Settings to MTP Tab* button (General tab)
- ⇨ Click the *Write MTP (sel)* button for saving the configuration to memory
- ⇨ Choose command Type 0 (command $A2_{HEX}$) or 2 (command $A3_{HEX}$) in the EXTERNAL CONFIGURATION section (EXT tab)
- ⇨ Activate the measurement with the Start button

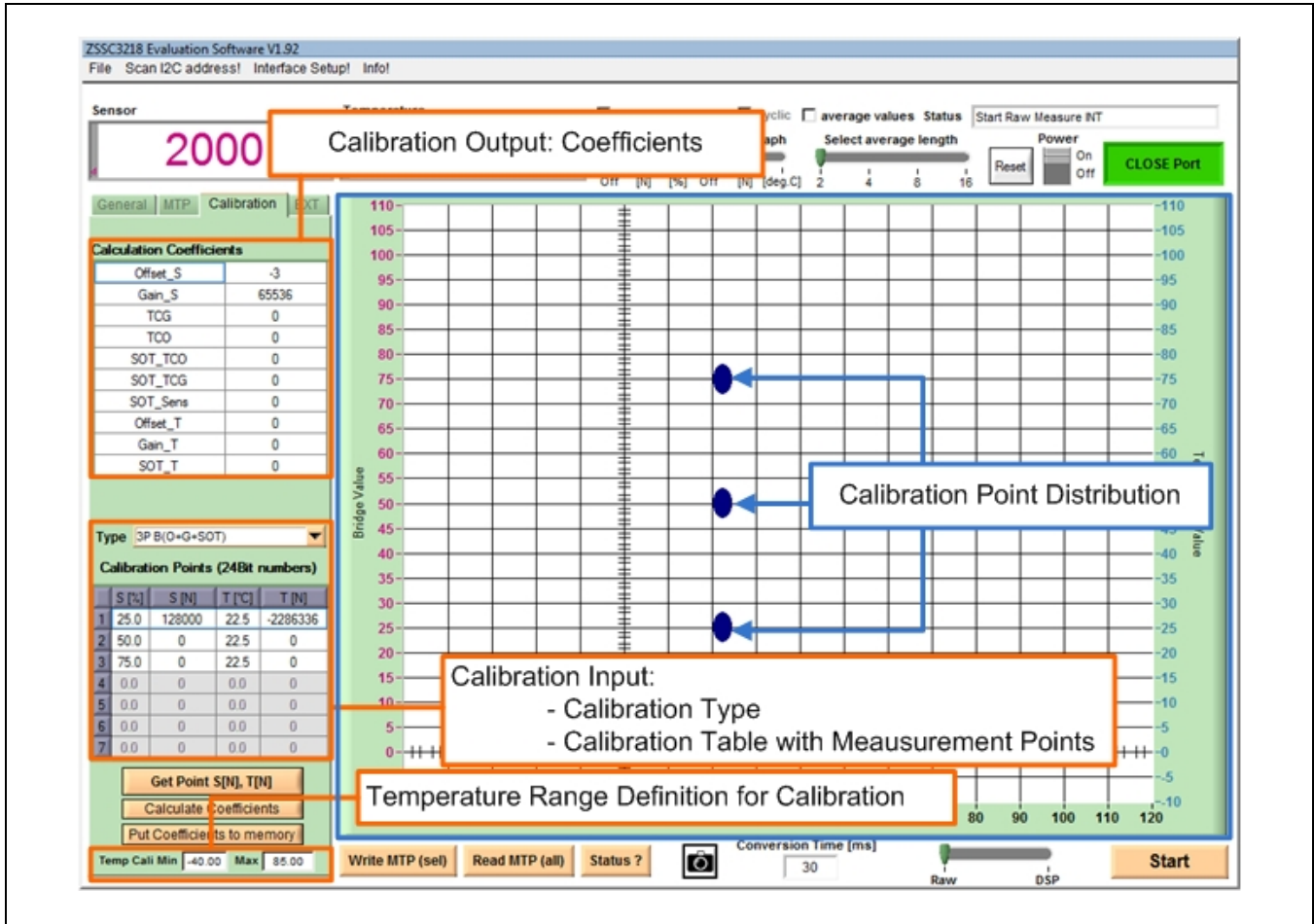See Figure 4.10 for a graphical display.

Figure 4.10 Sensor Configuration Usage
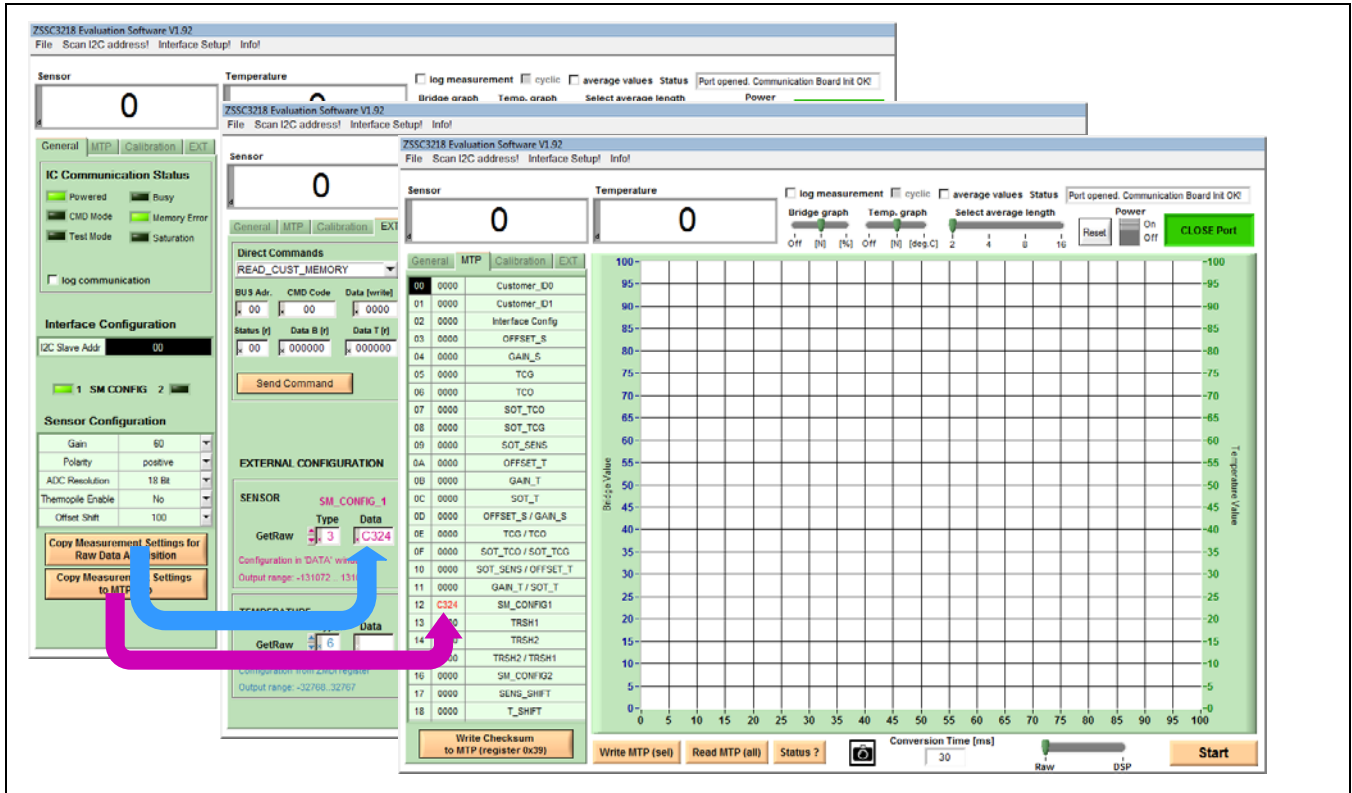
4.8. GUI – Calibration Tab

The primary purpose of the *Calibration* tab is the overview of the calibration data and the resulting coefficients. This tab is divided in two sections: the input and the output of the calibration process (see Figure 4.11).

Figure 4.11 Calibration Tab Structure

4.8.1. Calibration Input

The data input section is located in the lower left of the *Calibration* tab. In this table, data points are defined with their reference information for the external sensor and temperature and the corresponding measurement results. Above the calibration point table, the calibration type can be selected in a drop-down menu. Available calibration types are described in Table 4.7.

Table 4.7   Calibration Types

Type	Calculated Coefficients	Required number of data points	
		Ext. Sensor	Temp
2 Point	OFFSET_B, GAIN_B	2	0
3 Point	OFFSET_B,GAIN_B, SOT_B	3	0
3 Point	OFFSET_T,GAIN_T, SOT_T	0	3
4 Point	OFFSET_B, GAIN_B, TCO, TCG, OFFSET_T, GAIN_T	2	2
5 Point	OFFSET_B, GAIN_B, TCO, OFFSET_T, GAIN_T, SOT_TCO, SOT_B, SOT_T	3	3
6 Point	OFFSET_B,GAIN_B, TCO, TCG, OFFSET_T, GAIN_T,SOT_TCO, SOT_TCG, SOT_T	2	3
7 Point	OFFSET_B,GAIN_B, TCO, TCG, OFFSET_T, GAIN_T,SOT_TCO, SOT_TCG,SOT_T, SOT_B	3	3

Depending on the calibration type, the corresponding number of calibration points is displayed in the main graph to illustrate the coverage of the measurement range. The calibration table contains the relevant points for coefficient calculation.

Entry descriptions for the calibration table:

S[%] – S stands for the external sensor measurement. The point should be entered as a percent of the full measurement range for the bridge sensor measurement.

P[N] – Raw bridge measurement result in counts.

T[°C] – Temperature in degrees Celsius.

T[N] – Raw temperature measurement result in counts.

Example:

If the final application is specified from 800 to 1200 mbar, 5 % is then 820 mbar and 95% is 1180 respectively. Assuming the temperature range is from –40° to 80° Celsius, the initial calibration table for a 7-point calibration could be defined as shown in Figure 4.12.

Figure 4.12 Calibration Point Definition
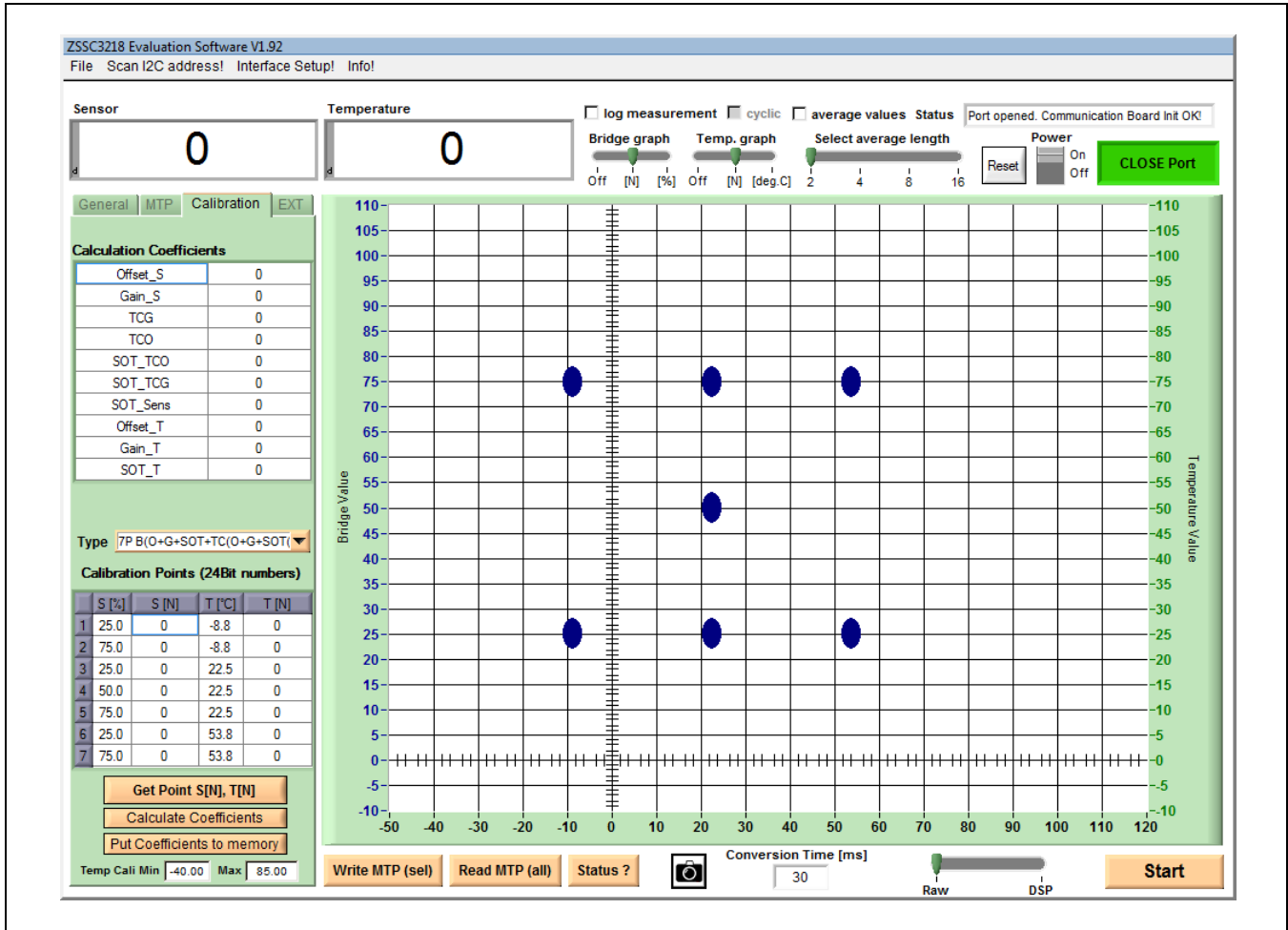
Note: The definition of the temperature range in the calibration must be entered at the bottom of the *Calibration* tab. The degree Celsius entries in the "Calibration Points" table must match the range definition.

4.8.2.   Calibration Output

The upper left section in the *Calibration* tab is the coefficient table, which is where the coefficients are displayed after calculation. If one of the coefficients exceeds the range limit, its value appears as a red number. In this case, the status window displays "Coefficients Range ERROR!"

4.8.3. Calibration Process

The following process for data collection describes one measurement point acquisition, representative for all calibration points. A detailed description for the calibration flow can be found in the document *ZSSC3218 Application Circuits and Calibration* (see section 6).

Table 4.8   Calibration Data Collection

Step	Description	Location
1	Connect the Communication Board to a PC and make all necessary connections from it to the ZSSC3218 on the Evaluation Board or an alternative user board.	
2	Start the Evaluation Software.	
3	Create a calibration setup for the user's system that is consistent with the sensor's characteristics. Click the *Copy Measurement Settings to MTP Tab* button to pass the current configuration in the *MTP tab* and write it to the *SM_configX* register as described in section 4.7.4. Recommendation: For temperature measurement, use Type 6 (command $A6_{HEX}$), which loads the configuration that has been trimmed and programmed by IDT from the internal temperature register. Alternatively, a pre-defined default setup can be loaded (see section 4.3.1)	*General* tab/ *MTP* tab
4	Choose the calibration type via the *Type* drop-down menu.	*Calibration* tab
5	Set up the desired external bridge sensor and temperature conditions so that the measurement can be performed in a stable state. Enter the reference conditions *S[%]* and *T[°C]* in the corresponding rows in the C*alibration Points* table.	*Calibration* tab
6	Select the row where the present measurement data should be entered by clicking one of the row numbers from 1 to 7. Click on the *Get Point S[N], T[N]* button to trigger a single measurement. The measurement results will be automatically displayed in the table (see Figure 4.13).	*Calibration* tab
7	The data for the remaining calibration points must be filled in the table by repeating steps 5 and 6 for each point.	*Calibration* tab

**Figure 4.13 Measuring a Calibration Data Point**
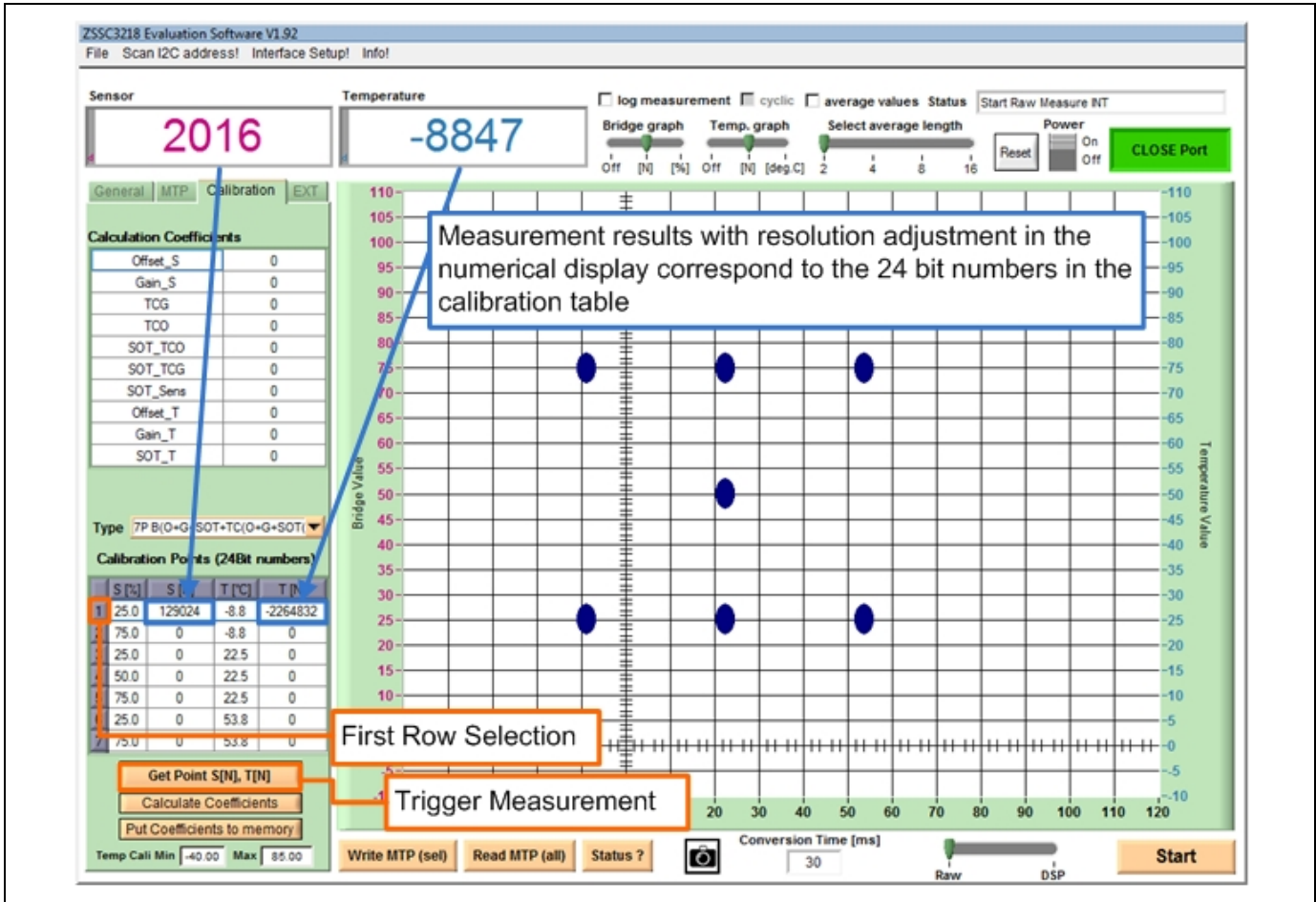
After the calibration point acquisition is completed, the coefficients calculation can be performed. Completion of the calibration process is described in the following steps. Figure 4.14 illustrates these steps with blue arrows.

Table 4.9   Calculate and Write Coefficients

Step	Description	Location
1	Calculate the coefficients by clicking the *Calculate Coefficients* button. The coefficients will be displayed in the "Calculation Coefficients" table.	*Calibration* tab
2	Transfer the new coefficients to the *MTP* tab by clicking on the *Put Coefficients to memory* button. The values are concurrently selected for writing (turn red).	*Calibration* tab
3	For DSP-corrected bridge measurement, the *SM_configX* register must contain the same configuration as during calibration, so click on the *Copy Measurement Settings to MTP Tab* button. The coded configuration appears red-colored in *SM_configX*.	*General* tab
4	Write the new coefficients into the MTP via the *Write MTP(sel)*. Read the MTP contents to ensure that the coefficients have been written to the memory.	*MTP* tab

Step	Description	Location
5	The final step after successfully writing calibration and coefficients to memory is to generate and write the checksum for the full user memory. The *Write Checksum to memory* (register 39$_{HEX}$) button triggers the ZSSC3218 internal calculation of the checksum and writes it in the *Checksum* register.	*MTP* tab
6	Finished! After the next reset of the ZSSC3218, the new coefficients will be used to calculate the output values if the measurement mode slider is switched to the *DSP* position. In the *General* tab the *Memory Error* LED turns off.	

Figure 4.14 Coefficient Calculation
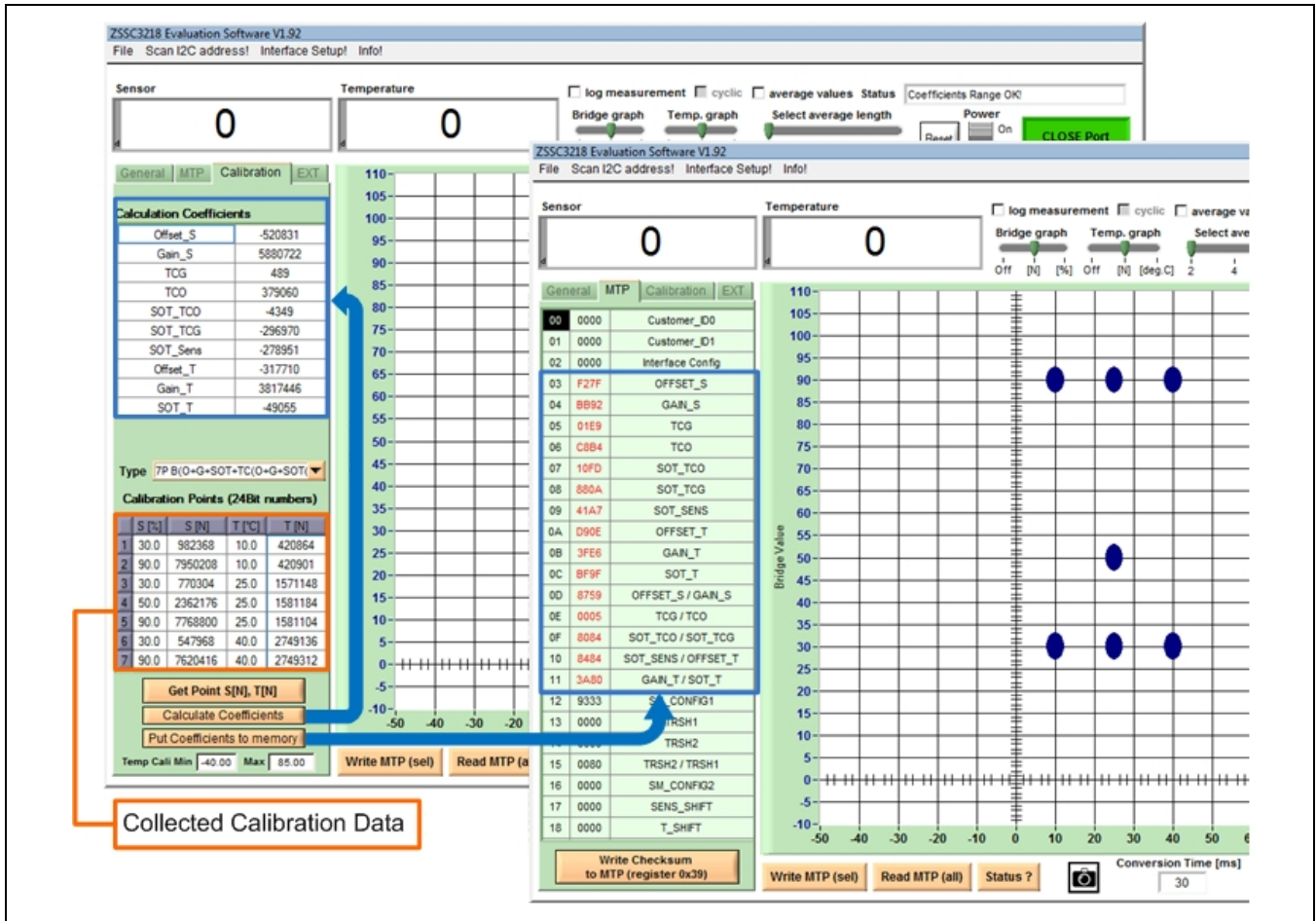
5   Sensor Replacement Board (SRB)

The Evaluation Kit includes a sensor replacement board. It allows the customer to do the first steps with the ZSSC3218 without a final application sensor module.

The sensor replacement board consists of two potentiometers between the positive and negative sensor line, which can be adjusted to represent the change in resistance of a sensor. One is for the coarse resistance regulation; the other for the fine adjustment.

Figure 5.1   Sensor Replacement Board
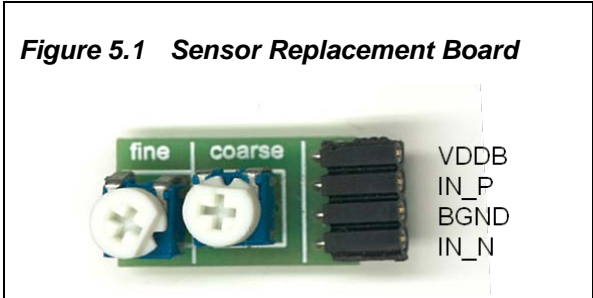
The SRB has an internal resistance of approximately 2kΩ. The specific resistance values between the single pins are given in Figure 5.2.

Figure 5.2   Resistance Network of the SRB
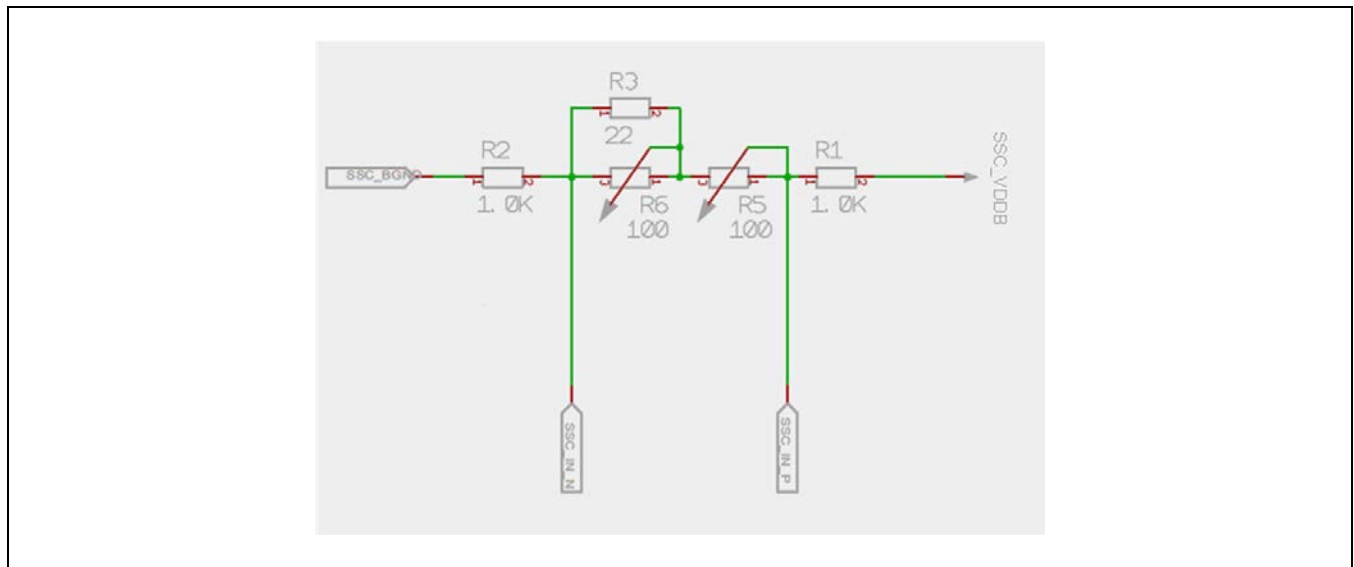
6 Related Documents and Files

ZSSC3218 Documents
ZSSC3218 Data Sheet
ZSSC33218 Feature Sheet
ZSSC3218 Application Note – Application Circuits
ZSSC3218 Calibration

Visit www.IDT.com/ZSSC3218 and www.IDT.com/ZSSC3218KIT or contact your nearest sales office for the latest version of these documents.

7 Glossary

Term	Description
A2D	Analog-to-Digital
ACK	Acknowledge (interface's protocol indicator for successful data/command transfer)
ADC	Analog-to-Digital Converter or Conversion
ALU	Arithmetic Logic Unit
AZ	Auto-Zero (unspecific)
AZSM	Auto-Zero Measurement for External Sensor
AZTM	Auto-Zero Measurement for Temperature
CDIP	Ceramic Dual-Inline Package
CLK	Clock
DF	Data Fetch (this is a command type)
DLL	Dynamic-Link Library
DUT	Device Under Test
DSP	Digital Signal Processor (digital configuration, calibration, calculation, communication unit)
FSO	Full Scale Output (value in percent relative to the ADC maximum output code; resolution dependent)
LSB	Least Significant Bit ("fine" portion of the converted signal)
MSB	Most Significant Bit ("coarse" portion of the converted signal)
MTP	Multiple-Time Programmable
NACK	Not Acknowledge (interface's protocol indicator for unsuccessful data/command transfer)
PCB	Printed Circuit Board
POR	Power-On-Reset

Term	Description
PQFN	Power Quad Flat No Leads
SM	Signal Measurement
SOT	Second Order Term
SRB	Sensor Replacement Board
TM	Temperature Measurement

8   Document Revision History

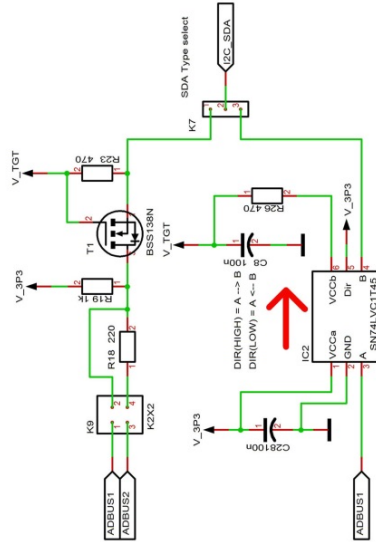| Revision.	Date	Description
1.00	November 5, 2015	First release.
	April 1, 2016	Changed to IDT branding.

Appendix A: Schematics Communication Board
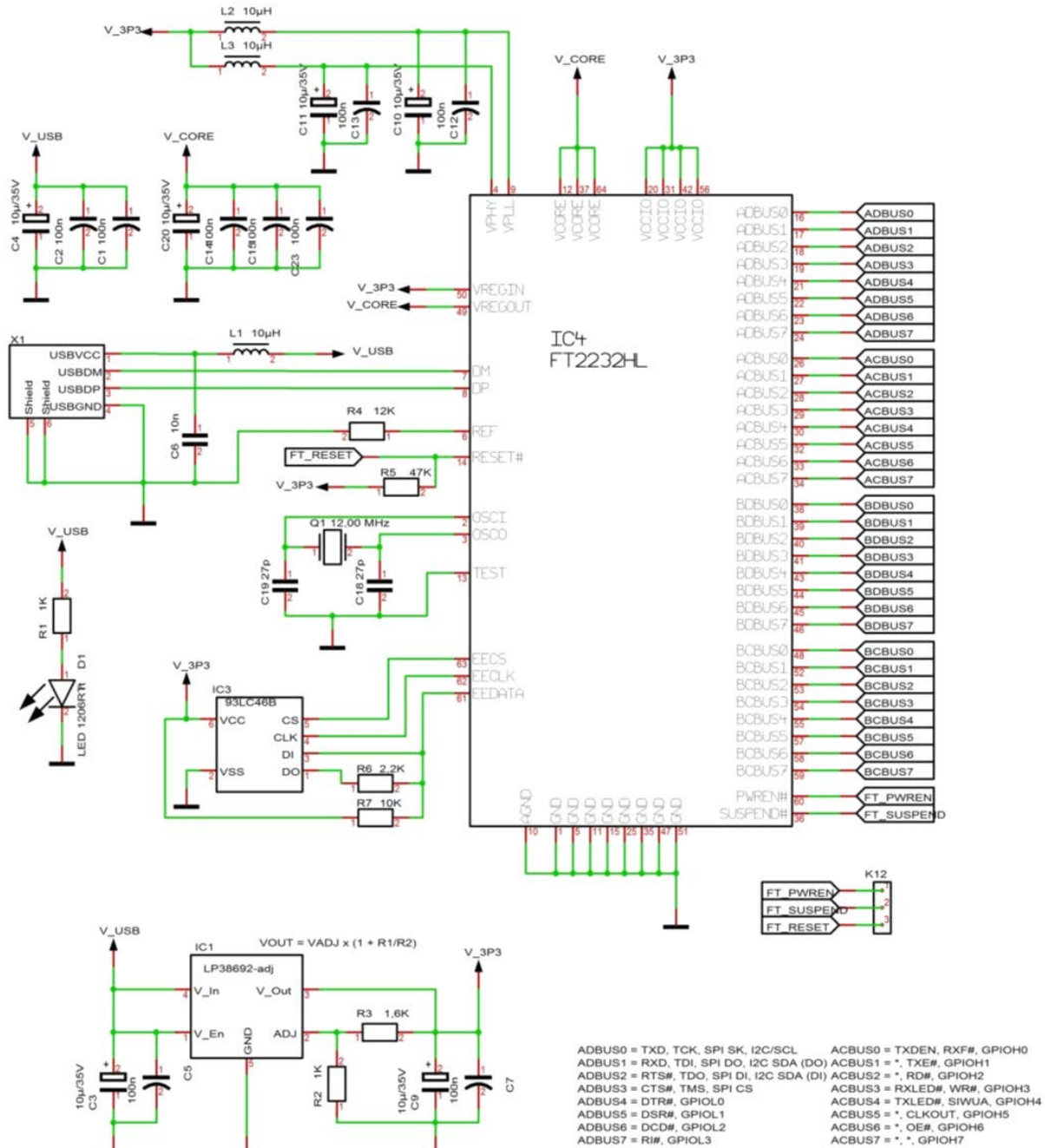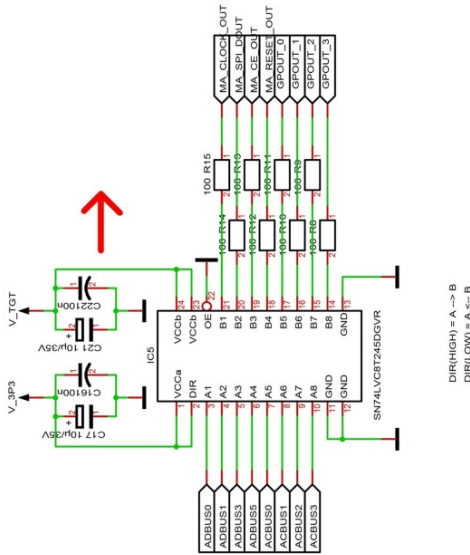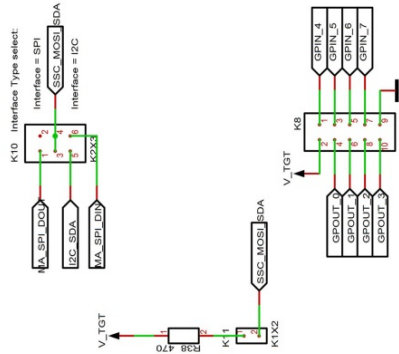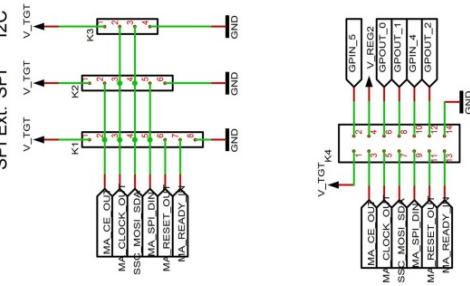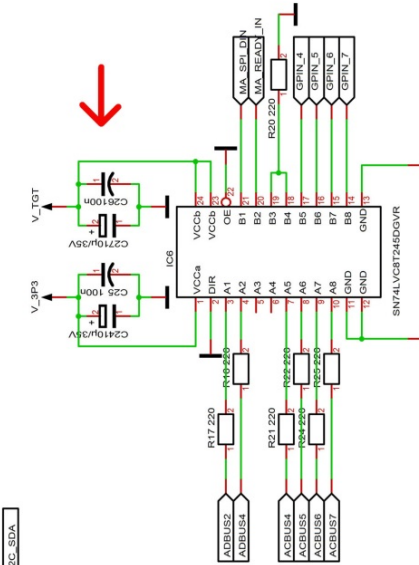
ADBUS0 = TXD, TCK, SPI SK, I2C/SCL
ADBUS1 = RXD, TDI, SPI DO, I2C SDA (DO)
ADBUS2 = RTS#, TDO, SPI DI, I2C SDA (DI)
ADBUS3 = CTS#, TMS, SPI CS
ADBUS4 = DTR#, GPIOL0
ADBUS5 = DSR#, GPIOL1
ADBUS6 = DCD#, GPIOL2
ADBUS7 = RI#, GPIOL3

ACBUS0 = TXDEN, RXF#, GPIOH0
ACBUS1 = *, TXE#, GPIOH1
ACBUS2 = *, RD#, GPIOH2
ACBUS3 = RXLED#, WR#, GPIOH3
ACBUS4 = TXLED#, SIWUA, GPIOH4
ACBUS5 = *, CLKOUT, GPIOH5
ACBUS6 = *, OE#, GPIOH6
ACBUS7 = *, *, GPIOH7

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5V -> 12V DCDC Converter

VOUT = VADJ x (1 + R1/R2)

VOUT = VADJ x (1 + R1/R2)
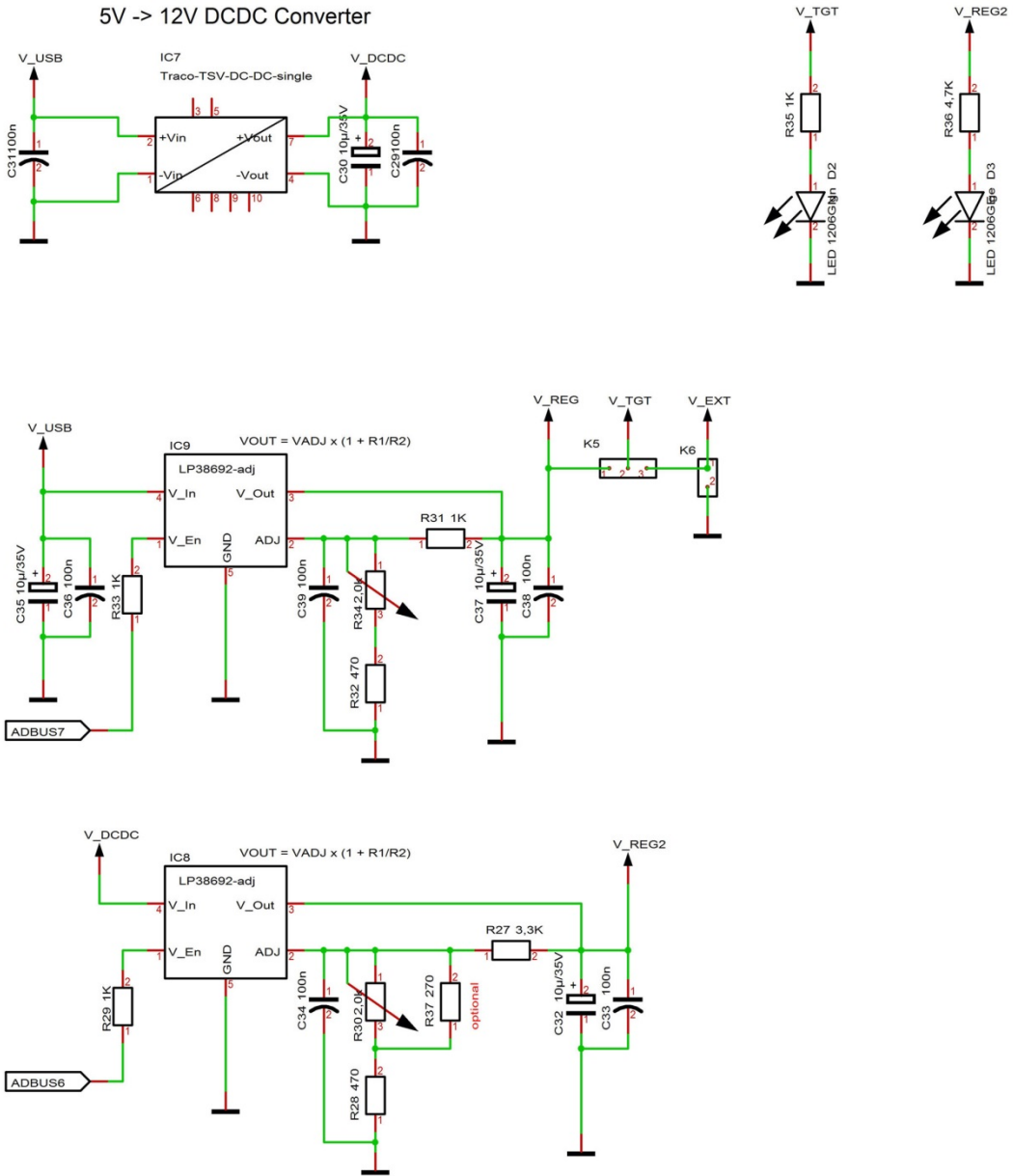
Appendix B: Schematic Evaluation Board
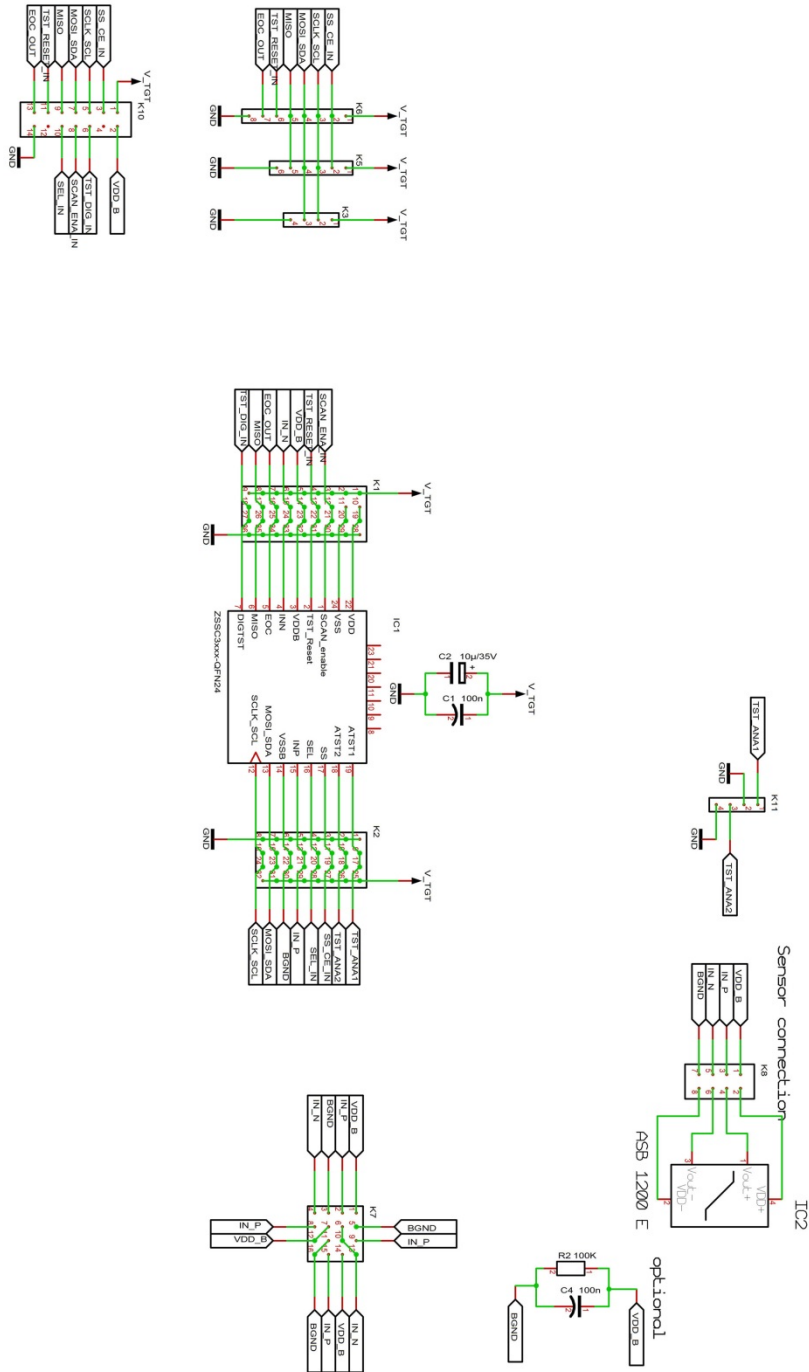
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